

# PCA8536

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Rev. 3 — 6 October 2021

Product data sheet

## 1 General description

The PCA8536 is a peripheral device which interfaces to almost any Liquid Crystal Display (LCD)<sup>1</sup> with low multiplex rates. It generates the drive signals for any multiplexed LCD containing up to eight backplanes, up to 44 segments, and up to 320 elements. The PCA8536 is compatible with most microcontrollers and communicates via the two-line bidirectional I<sup>2</sup>C-bus (PCA8536AT) or a three line unidirectional SPI-bus (PCA8536BT). Communication overheads are minimized using a display RAM with auto-incremented addressing.

The PCA8536 features an on-chip PWM controller for LED illumination. Up to six independent channels can be configured. Each channel has 128 levels allowing the possibility for two RGB controllers. Each of them provides over 2 million colors. Each channel can also be used for static drive.

## 2 Features and benefits

- AEC Q100 compliant for automotive applications.
- Single-chip 320 segment LCD controller and driver with 6 channel PWM generator
- 6 channel PWM generator for backlight LED illumination
- Selectable display bias configuration
- Wide range for digital power supply: from 1.8 V to 5.5 V
- Wide LCD supply range: from 2.5 V for low threshold LCDs and up to 9.0 V for high threshold twisted nematic LCDs
- Low power consumption
- Selectable backplane drive configuration: 4, 6, or 8 backplane multiplexing
- LCD and logic supplies may be separated
- 320-bit RAM for display data storage
- 6 PWM outputs with a 7-bit resolution (128 steps) and drivers for external transistors
- Programmable PWM frame frequency to avoid LCD backlight flickering
- Extended temperature range up to 95 °C
- 400 kHz I<sup>2</sup>C-bus interface (PCA8536AT)
- 5 MHz SPI-bus interface (PCA8536BT)
- Programmable frame frequency in the range of 60 Hz to 300 Hz in steps of 10 Hz; factory calibrated
- 320 segments driven allowing:
  - up to 40 7-segment alphanumeric characters
  - up to 20 14-segment alphanumeric characters
  - any graphics of up to 320 elements
- Manufactured in silicon gate CMOS process

<sup>1</sup> The definition of the abbreviations and acronyms used in this data sheet can be found in [Section 19](#).



### 3 Applications

- Car Radio
- Climate Control
- Dash board display

### 4 Ordering information

Table 1. Ordering information

Type number	Interface type	Topside mark	Package		
			Name	Description	Version
PCA8536AT/Q900/1	I <sup>2</sup> C-bus	PCA8536AT/Q900	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1
PCA8536BT/Q900/1	SPI-bus	PCA8536BT/Q900	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1

#### 4.1 Ordering options

Table 2. Ordering options

Type number	Orderable part number	Package	Packing method <sup>[1]</sup>	Minimum order quantity	Temperature
PCA8536AT/Q900/1	PCA8536AT/Q900/1,1 <sup>[2]</sup>	TSSOP56	reel 13 inch q1 non dry pack	2000	T <sub>amb</sub> = -40 °C to +95 °C
	PCA8536AT/Q900/1Y	TSSOP56	reel 13 inch q1 dry pack	2000	T <sub>amb</sub> = -40 °C to +95 °C
PCA8536BT/Q900/1	PCA8536BT/Q900/1,1 <sup>[3]</sup>	TSSOP56	reel 13 inch q1 non dry pack	2000	T <sub>amb</sub> = -40 °C to +95 °C
	PCA8536BT/Q900/1Y	TSSOP56	reel 13 inch q1 dry pack	2000	T <sub>amb</sub> = -40 °C to +95 °C

[1] Standard packing quantities and other packaging data are available at [www.nxp.com/packages/](http://www.nxp.com/packages/).

[2] Discontinuation Notice 202107021DN - drop in replacement is PCA8536AT/Q900/1Y - this is documented in PCN202102010F01.

[3] Discontinuation Notice 202107021DN - drop in replacement is PCA8536BT/Q900/1Y - this is documented in PCN202102010F01.

5 Block diagram

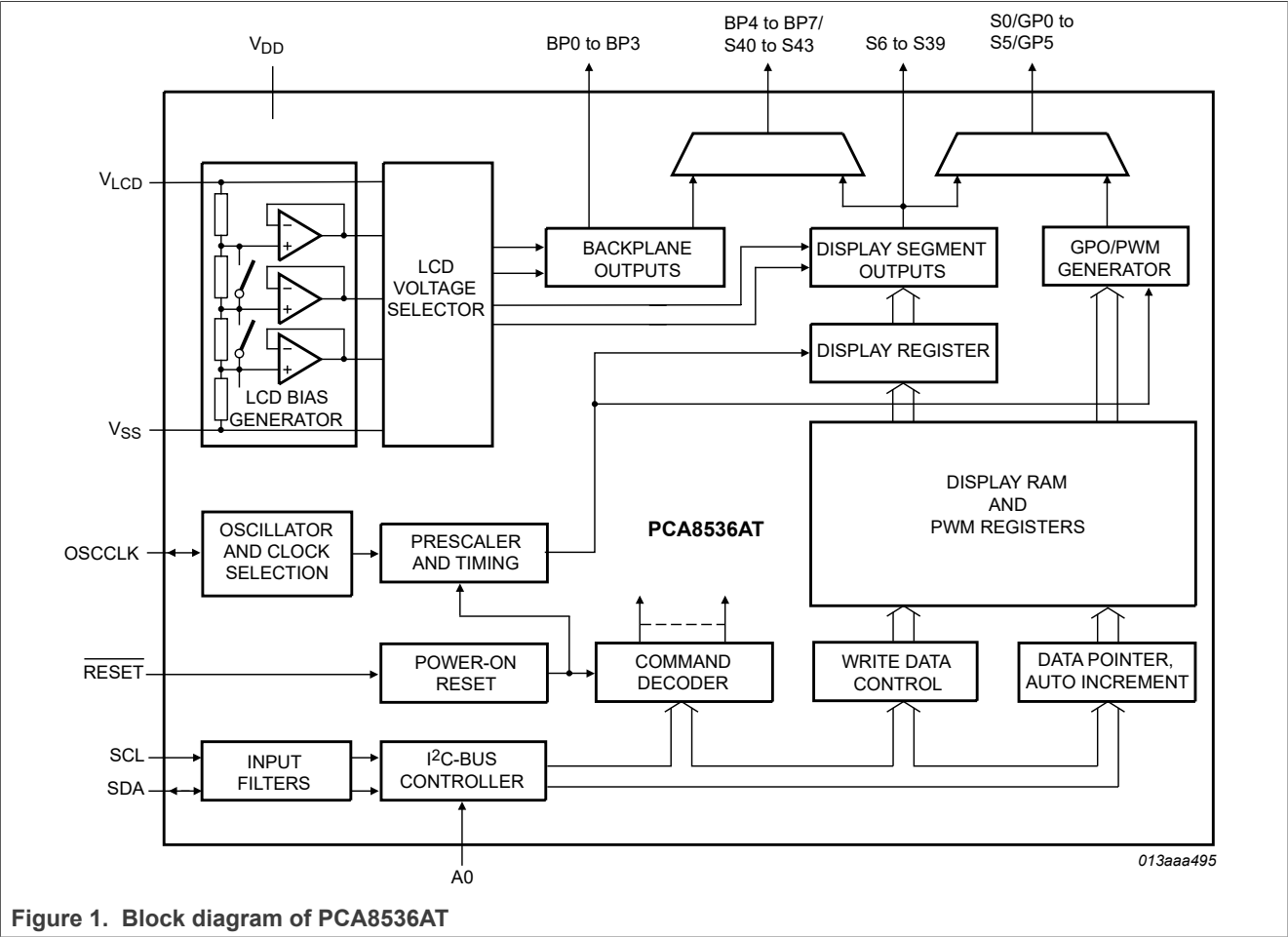
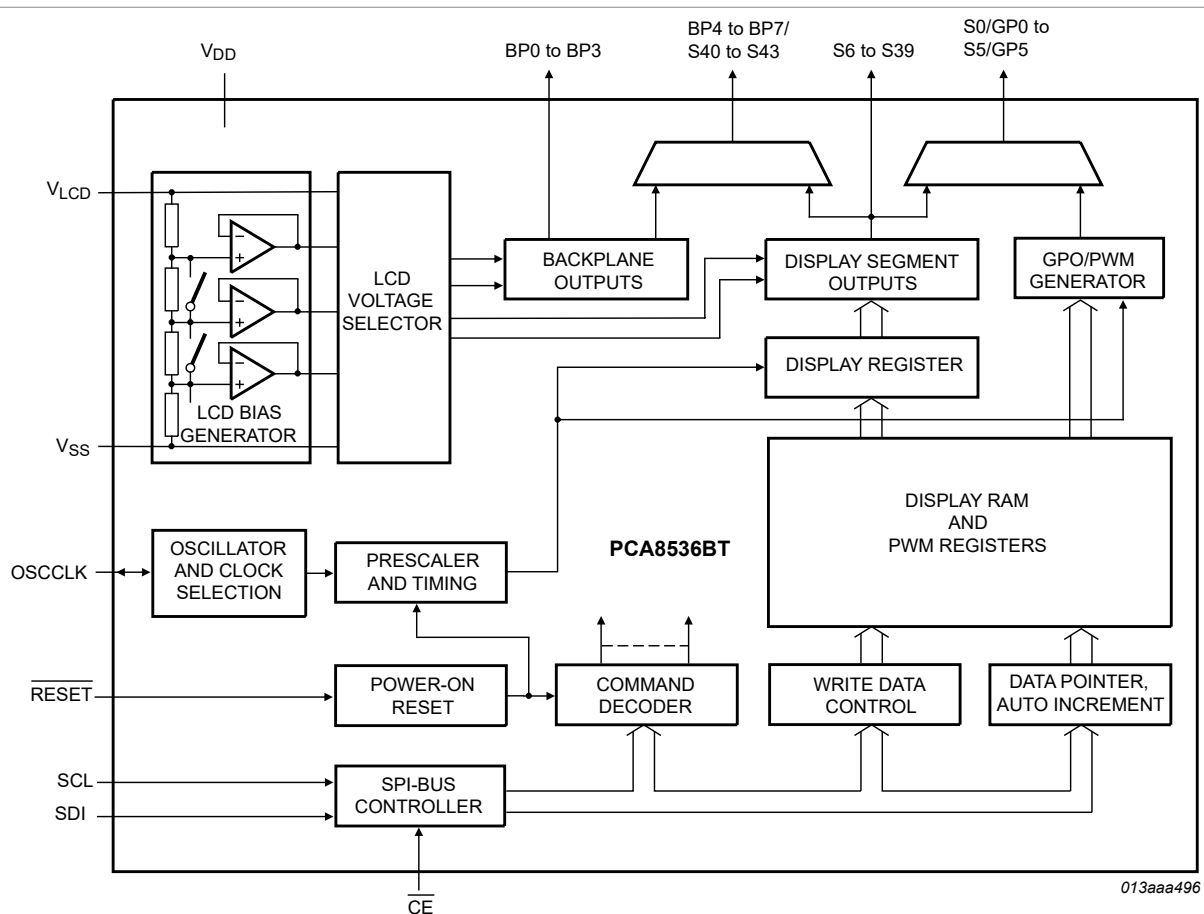


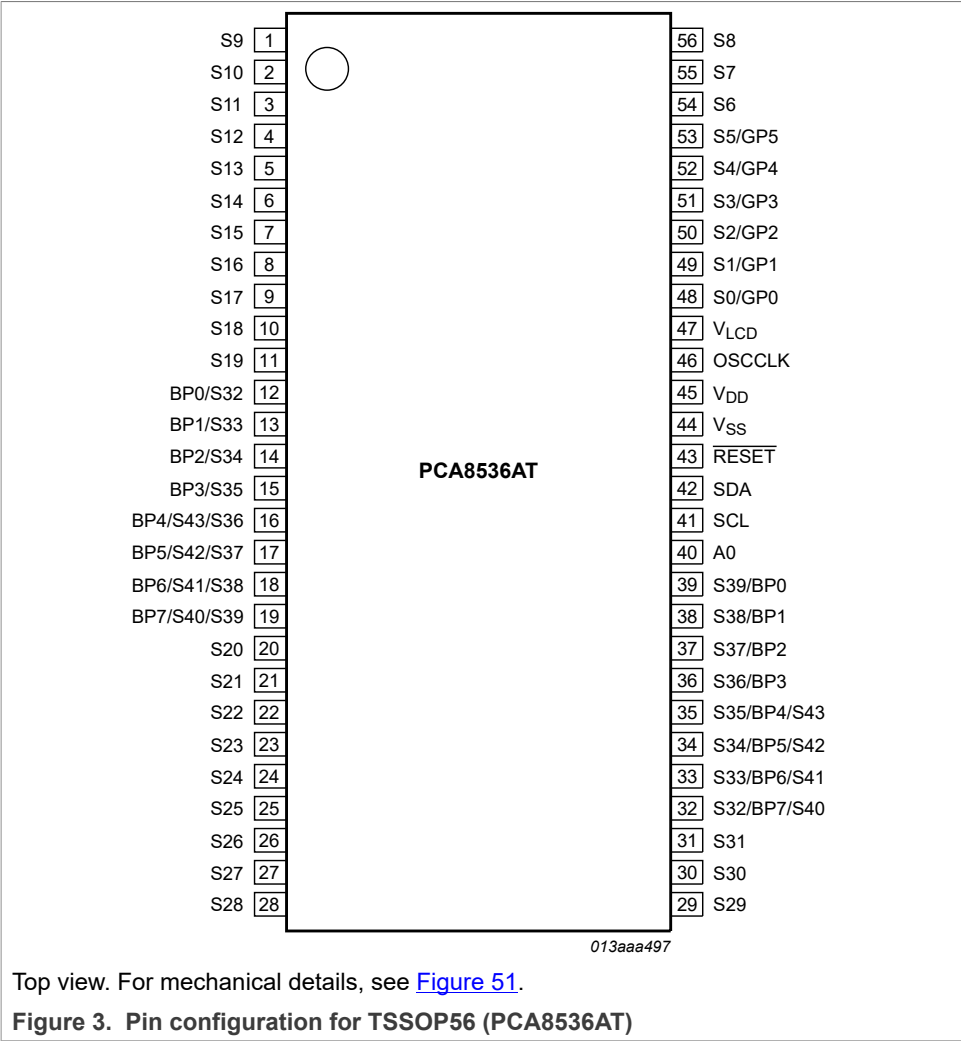
Figure 1. Block diagram of PCA8536AT



**Figure 2. Block diagram of PCA8536BT**

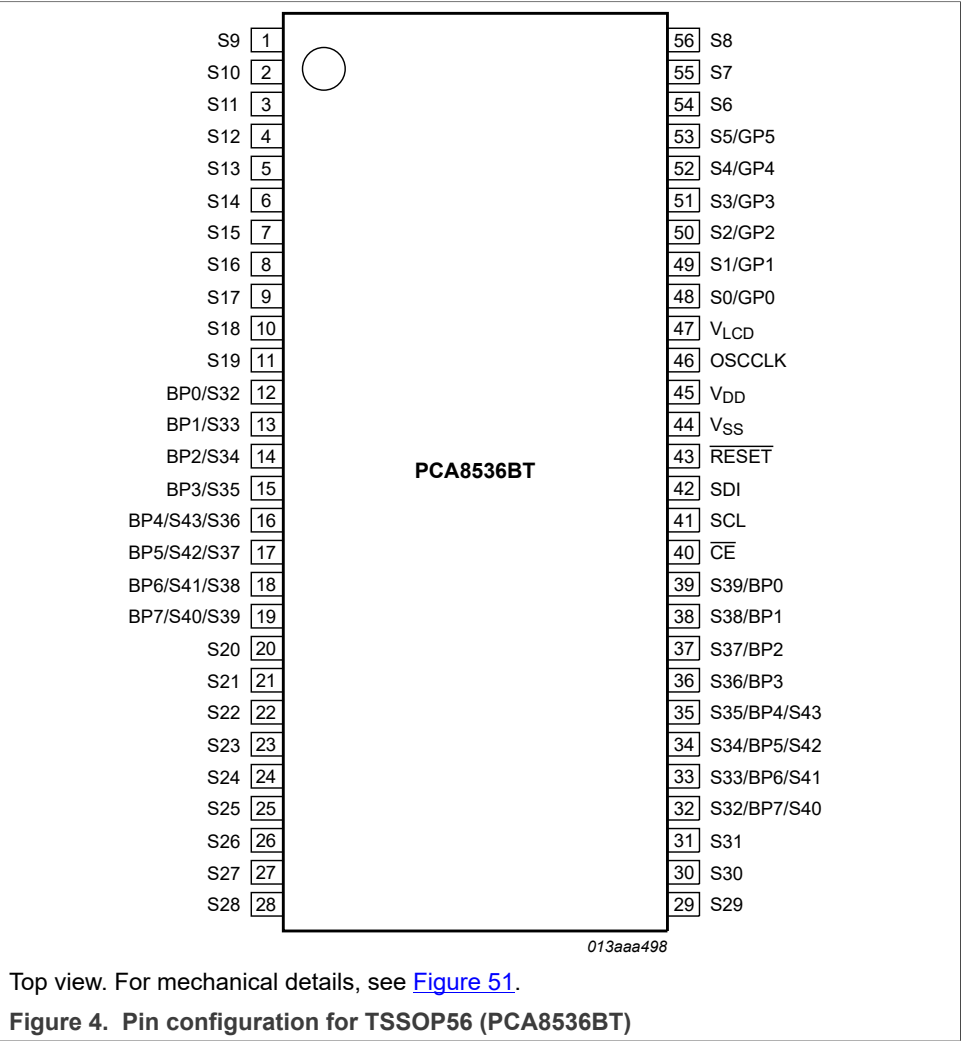
## 6 Pinning information

## 6.1 Pinning



Top view. For mechanical details, see [Figure 51](#).

Figure 3. Pin configuration for TSSOP56 (PCA8536AT)



Top view. For mechanical details, see [Figure 51](#).

Figure 4. Pin configuration for TSSOP56 (PCA8536BT)

## 6.2 Pin description

Table 3. Pin description of PCA8536AT and PCA8536BT

Pin	Symbol	Type	Description
1 to 11	S9 to S19	output	LCD segment
20 to 31	S20 to S31	output	LCD segment
43	RESET	input	active LOW reset input
44	V <sub>SS</sub>	supply	ground supply voltage
45	V <sub>DD</sub>	supply	supply voltage
46	OSCCLK	input/output	external clock input/internal oscillator output
47	V <sub>LCD</sub> <sup>[1]</sup>	supply	LCD supply voltage
48 to 53	S0/GP0 to S5/GP5	output	LCD segment/GPO (PWM) output
54 to 56	S6 to S8	output	LCD segment
Pin layout depending on backplane swap configuration <sup>[2]</sup>			
	<b>BPS = 0</b>	<b>BPS = 1<sup>[3]</sup></b>	
12	BP0	S32	output LCD backplane/LCD segment
13	BP1	S33	
14	BP2	S34	
15	BP3	S35	
16	BP4/S43	S36	
17	BP5/S42	S37	
18	BP6/S41	S38	
19	BP7/S40	S39	
32	S32	BP7/S40	
33	S33	BP6/S41	
34	S34	BP5/S42	
35	S35	BP4/S43	
36	S36	BP3	
37	S37	BP2	
38	S38	BP1	
39	S39	BP0	
Pin layout depending on product and bus type			
	<b>PCA8536AT</b>	<b>PCA8536BT</b>	
40	A0		I <sup>2</sup> C-bus target address selection
		$\overline{\text{CE}}$	SPI-bus chip enable - active LOW
41	SCL		I <sup>2</sup> C-bus serial clock
		SCL	SPI-bus serial clock

Table 3. Pin description of PCA8536AT and PCA8536BT...continued

Pin	Symbol	Type	Description
42	SDA	input/output	I <sup>2</sup> C-bus serial data
	SDI	input	SPI-bus data input

[1]  $V_{LCD}$  must be equal to or greater than  $V_{DD}$ .

[2] Effect of backplane swapping is illustrated in [Figure 5](#).

[3] Bit BPS is explained in [Section 7.1.4](#).

## 7 Functional description

The PCA8536 is a versatile peripheral device designed to interface any microcontroller to a wide variety of LCDs and 6 backlight LEDs. It can directly drive any multiplexed LCD containing up to eight backplanes and up to 44 segments.

### 7.1 Commands of PCA8536

The PCA8536 is controlled by 15 commands, which are defined in [Table 4](#). Any other combinations of operation code bits that are not mentioned in this document may lead to undesired operation modes of PCA8536.

Table 4. Commands of PCA8536

Command name	Register selection RS[1:0] <sup>[1]</sup>		Bits								Reference
			7	6	5	4	3	2	1	0	
initialize	0	0	0	0	0	1	0	1	1	0	<a href="#">Section 7.1.1</a>
OTP-refresh	0	0	1	1	1	1	0	0	0	0	<a href="#">Section 7.1.2</a>
PWM-inversion	0	0	0	0	0	1	0	1	0	PWMI	<a href="#">Section 7.1.3</a>
mode-settings	0	0	0	1	0	1	BPS	INV	PD	E	<a href="#">Section 7.1.4</a>
oscillator-control	0	0	0	0	0	1	1	EFR	COE	OSC	<a href="#">Section 7.1.5</a>
GPO-output-config	0	0	1	1	0	0	GPM1[1:0]		GPM0[1:0]		<a href="#">Section 7.1.6</a>
	0	0	1	1	0	1	GPM3[1:0]		GPM2[1:0]		
	0	0	1	1	1	0	GPM5[1:0]		GPM4[1:0]		
set-MUX-mode	0	0	0	0	0	0	0	0	M[1:0]		<a href="#">Section 7.1.7</a>
set-bias-mode	0	0	0	0	0	0	0	1	B[1:0]		<a href="#">Section 7.1.8</a>
frame-frequency-LCD	0	0	0	0	1	FD[4:0]					<a href="#">Section 7.1.9</a>
frame-frequency-PWM	0	0	0	1	0	0	FP[3:0]				<a href="#">Section 7.1.10</a>
GPO-static-data	0	0	0	1	1	0	0	GPO2	GPO1	GPO0	<a href="#">Section 7.1.11</a>
	0	0	0	1	1	0	1	GPO5	GPO4	GPO3	
load-data-pointer-LCD	0	0	1	0	DP[5:0]						<a href="#">Section 7.1.12</a>
load-data-pointer-PWM	0	0	0	1	1	1	0	PP[2:0]			<a href="#">Section 7.1.13</a>
write-RAM-data	0	1	D[7:0]								<a href="#">Section 7.1.14</a>
write-PWM-data	1	0	0	P[6:0]							<a href="#">Section 7.1.15</a>

[1] Information about control byte and register selection see [Section 8.1](#).

### 7.1.1 Command: initialize

This command generates a chip-wide reset. It has the same function as the  $\overline{\text{RESET}}$  pin. Reset takes 1 ms to complete.

Table 5. Initialize - initialize command bit description

Bit	Symbol	Value	Description
7 to 0	-	0001 0110	fixed value

### 7.1.2 Command: OTP-refresh

During production and testing of the device, each IC is calibrated to achieve the specified accuracy of the frame frequency. This calibration is performed on EPROM cells called One Time Programmable (OTP) cells. The device reads these cells every time the OTP-refresh command is sent. This instruction has to be sent after a reset has been made and before the display is enabled.

This command will be completed after a maximum of 30 ms and requires either the internal or external clock to run. If the internal oscillator is not used, then a clock must be supplied to the OSCCLK pin. If the OTP-refresh instruction is sent and no clock is present, then the request is stored until a clock is available.

**Remark:** It is recommended not to enter power-down mode during the OTP refresh cycle.

Table 6. OTP-refresh - OTP-refresh command bit description

Bit	Symbol	Value	Description
7 to 0	-	1111 0000	fixed value

### 7.1.3 Command: PWM-inversion

It is possible to invert the output of the PWM generators. This function may be useful for counteracting EMC issues. The description of this mode can be found in [Section 7.11.2](#) page 45.

Table 7. PWM-inversion - PWM inversion command bit description

Bit	Symbol	Value	Description
7 to 1	-	0001 010	fixed value
0	PWMI		<b>PWM inversion mode</b>
		1	PWM inversion mode on
		0 <sup>[1]</sup>	PWM inversion mode off

[1] Default value.

### 7.1.4 Command: mode-settings

Table 8. Mode-settings - mode settings command bit description

Bit	Symbol	Value	Description
7 to 4	-	0101	fixed value
3	BPS		<b>backplane swapping</b>



Table 8. Mode-settings - mode settings command bit description...continued

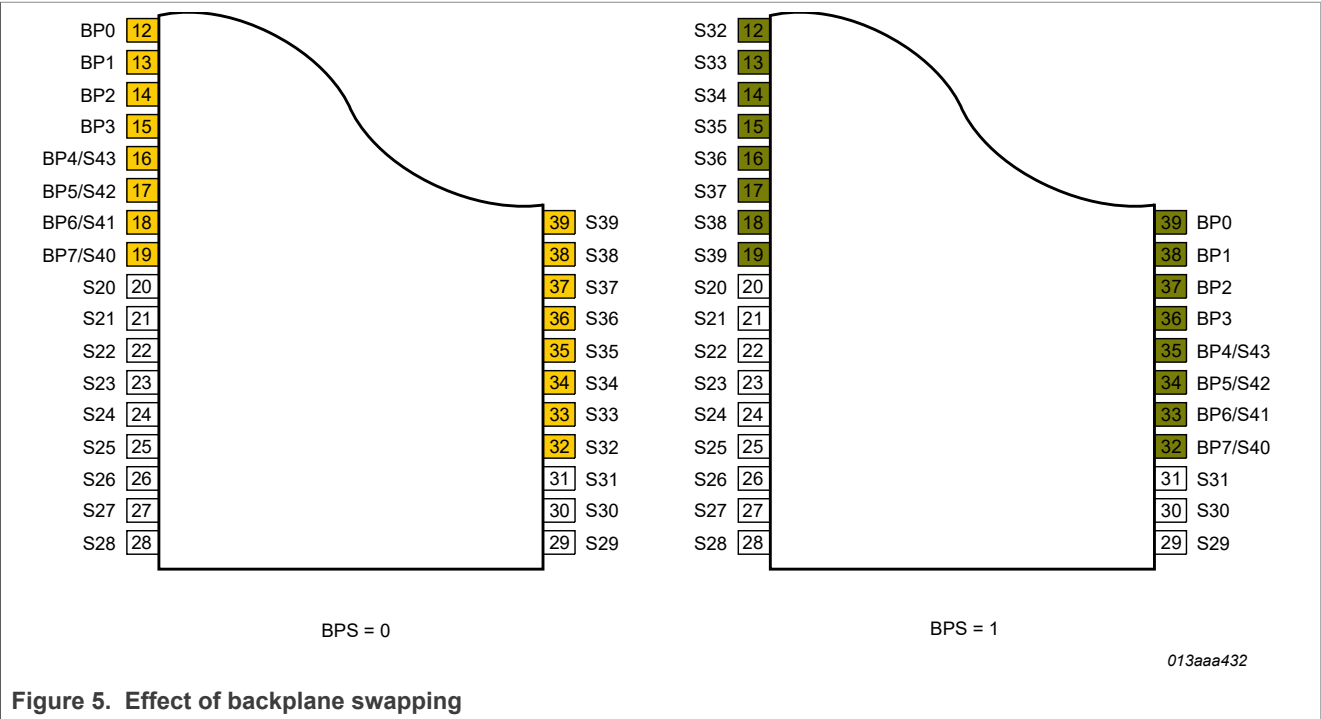
Bit	Symbol	Value	Description
		0 <sup>[1]</sup>	backplane configuration 0
		1	backplane configuration 1
2	INV		<b>set inversion mode</b>
		0 <sup>[1][2]</sup>	Driving scheme A: LCD line inversion mode
		1	Driving scheme B: LCD frame inversion mode
1	PD		<b>set power mode</b>
		1	power-down mode; backplane and segment outputs are connected to V <sub>SS</sub> and the internal oscillator is switched off
		0 <sup>[1]</sup>	power-up mode
0	E		<b>display switch</b>
		0 <sup>[1]</sup>	display disabled; backplane and segment outputs are connected to V <sub>SS</sub>
		1	display enabled

[1] Default value.  
[2] See [Section 7.1.4.2](#).

7.1.4.1 Backplane swapping

Backplane swapping can be configured with the BPS bit (see [Table 8](#)). It moves the location of the backplane and the associated segment outputs from one side of the PCA8536 to the other. Backplane swapping is sometimes desirable to aid with the routing of PCBs that do not use multiple layers.

The BPS bit has to be set to the required value before enabling the display. Failure to do so does not damage the PCA8536 or the display, however unexpected display content may appear.



7.1.4.2 Line inversion (driving scheme A) and frame inversion (driving scheme B)

The DC offset of the voltage across the LCD is compensated over a certain period: line-wise in line inversion mode (driving scheme A) or frame-wise in frame inversion mode (driving scheme B). With the INV bit (see [Table 8](#)), the compensation mode can be switched.

In frame inversion mode, the DC value is compensated across two frames and not within one frame. Changing the inversion mode to frame inversion reduces the power consumption; therefore it is useful when power consumption is a key point in the application.

Frame inversion may not be suitable for all applications. The RMS voltage across a segment is better defined; however, since the switching frequency is reduced, there is possibility for flicker to occur.

The waveforms of [Figure 15](#) to [Figure 18](#) are showing line inversion mode. [Figure 19](#) shows an example of frame inversion.

7.1.4.3 Power-down mode

The power-down bit (PD) allows the PCA8536 to be put in a minimum power configuration. In order to avoid display artefacts, it is recommended to enter power-down only after the display has been switched off by setting bit E to logic 0.

During power-down, the internal oscillator is switched off and any selected PWM output is revert to the static value stored in bits GPO0 to GPO5. These bits may be programmed to give a static logic 0 or static logic 1 on selected GP0 to GP5 pins.

Table 9. Effect of the power-down bit (PD)

Effect on function	Mode settings	Effect of setting PD	
		0	1
backplane output	E = 1	normal function	V <sub>SS</sub>
segment output	E = 1	normal function	V <sub>SS</sub>
internal oscillator	OSC = 0, COE = 1	on	off
OSCCLK pin	OSC = 0, COE = 1	output of internal oscillator frequency	V <sub>DD</sub>
OSCCLK pin	OSC = 1	input clock	clock input, can be logic 0, logic 1, or left floating
GPO	static drive	static drive	static drive
GPO	PWM drive	PWM drive	static drive

With the following sequence, the PCA8536 can be set to a state of minimum power consumption, called power-down mode.

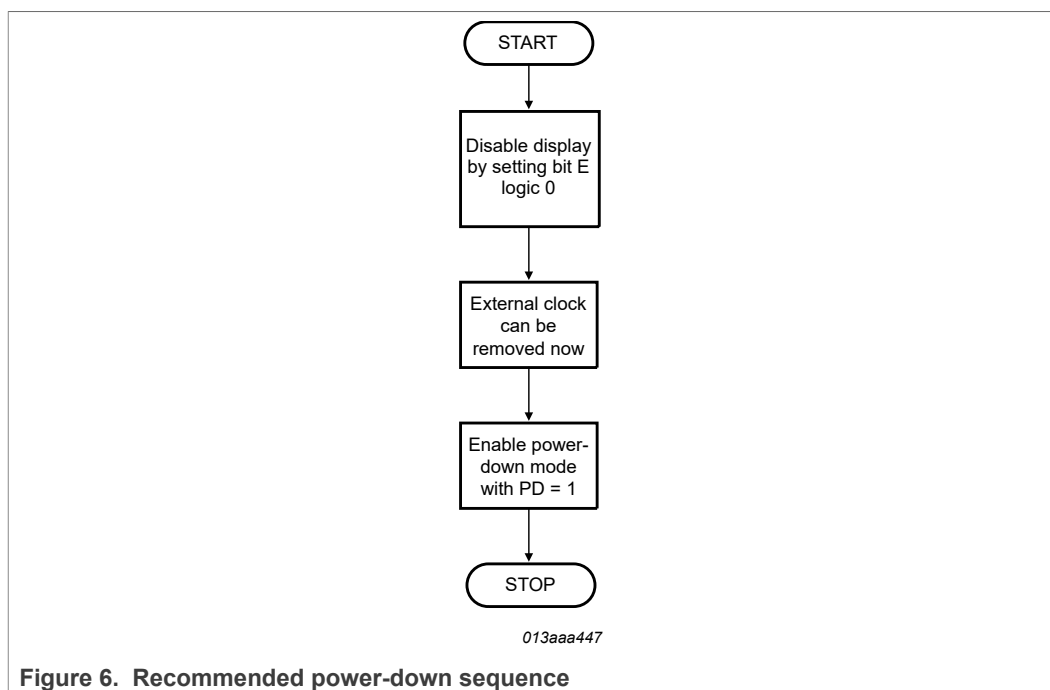


Figure 6. Recommended power-down sequence

**Remarks:**

- It is necessary to run the power-down sequence before removing the supplies. Depending on the application, care must be taken that no other signals are present at the chip input or output pins when removing the supplies (see [Section 9](#)). Otherwise it may cause unwanted display artifacts. In case of an uncontrolled removal of supply voltages, the PCA8536 will not be damaged.
- Static voltages across the liquid crystal display can build up when the external LCD supply voltage (V<sub>LCD</sub>) is on while the IC supply voltage is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts, V<sub>LCD</sub> and V<sub>DD</sub> must be applied or removed together.

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- A clock signal must always be supplied to the device when the display is active. Removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal. It is recommended to disable the display first and afterwards to remove the clock signal.

## 7.1.4.4 Display enable

The display enable bit (E) is used to enable and disable the display. When the display is disabled, all LCD outputs go to  $V_{SS}$ . This function is implemented to ensure that no voltage can be induced on the LCD outputs as it may lead to unwanted displays of segments.

Recommended start-up sequences are found in [Section 7.2.3](#)

**Remarks:**

- The state of display enable has no effect on the GPO outputs.
- Display enable is not synchronized to an LCD frame boundary. Therefore using this function to flash a display for prolonged periods is not recommended due to the possible build-up of DC voltages on the display.

## 7.1.5 Command: oscillator-control

The oscillator-control command switches between internal and external oscillator and enables or disables the pin OSCCLK. It is also used to define what the external frequency will be.

Table 10. Oscillator-control - oscillator control command bit description

Bit	Symbol	Value	Description
7 to 3	-	0001 1	fixed value
2	EFR		<b>external clock frequency</b> applied on pin OSCCLK
		0 <sup>[1]</sup>	9.6 kHz
		1	230 kHz
1	COE		<b>clock output enable for pin OSCCLK</b>
		0 <sup>[1]</sup>	clock signal not available on pin OSCCLK; pin OSCCLK is in 3-state
		1	clock signal available on pin OSCCLK
0	OSC		<b>oscillator source</b>
		0 <sup>[1]</sup>	internal oscillator running
		1	external oscillator used; pin OSCCLK becomes an input; used in combination with EFR to determine input frequency

[1] Default value.

The bits OSC, COE, and EFR control the source and frequency of the clock used to generate the LCD and PWM signals (see [Figure 7](#)). Valid combinations are shown in [Table 11](#).

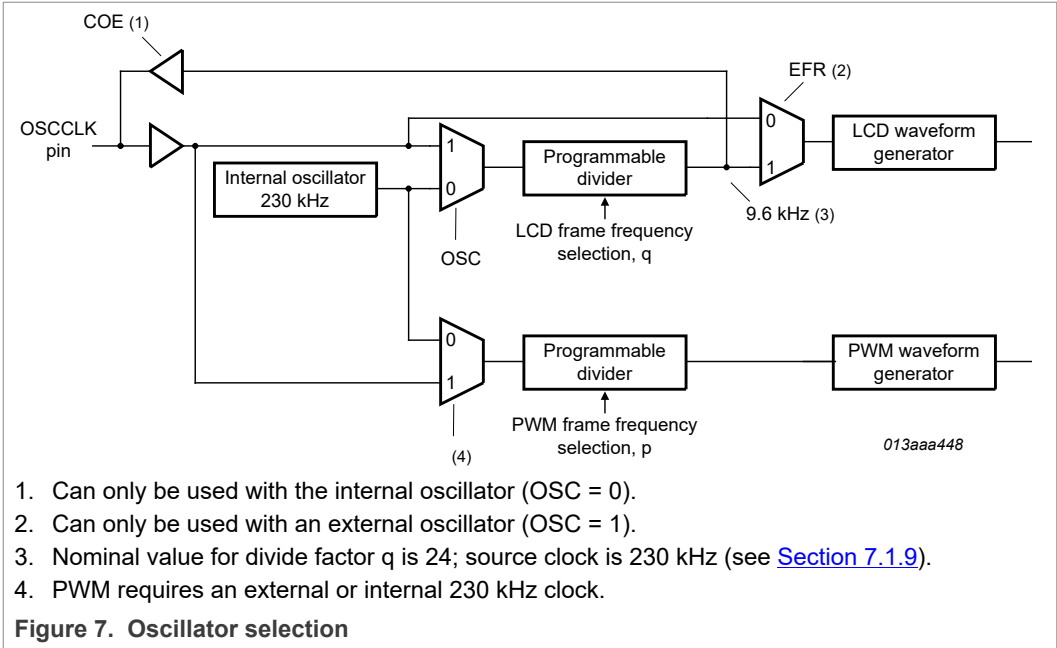


Table 11. Valid combinations of bits OSC, EFR, and COE

OSC	COE	EFR	OSCCLK pin	Clock source
0	0	not used	inactive; may be left floating	internal oscillator used
0	1	not used	output of internal oscillator frequency (prescaler)	internal oscillator used
1	not used	0	9.6 kHz input	OSCCLK pin
1	not used	1	230 kHz input	OSCCLK pin

Table 12. Typical use of bits OSC, EFR, and COE

Usage	OSC	CDE	EFR
LCD and/or PWM with internal oscillator	0	0	not used
LCD and PWM with external oscillator	1	not used	1
LCD with external oscillator	1	not used	0

7.1.5.1 Oscillator

The internal logic and LCD drive signals of the PCA8536 are timed either by the built-in oscillator or from an external clock.

Internal clock

When the internal oscillator is used, all LCD and PWM signals are generated from it. The oscillator runs at nominal 230 kHz. The relationship between this frequency and the LCD frame frequency is detailed in [Section 7.1.9](#). The relationship between this frequency and the PWM frame frequency is detailed in [Section 7.1.10](#).

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Control over the internal oscillator is made with the OSC bit (see [Section 7.1.5](#)). The internal oscillator is also switched on or off under certain combinations of modes which are described in [Table 13](#).

Table 13. Internal oscillator on/off table

PD	OSC	PWM	EFR	Internal oscillator state <sup>[1]</sup>
power-down	n.a.	n.a.	n.a.	off
power-up	internal oscillator	n.a.	n.a.	on
	external oscillator	off	n.a.	off
		on	9.6 kHz	on <sup>[2]</sup>
		on	230 kHz	off

[1] When RESET is active, the internal oscillator is off.

[2] Special case. The PWM generator needs 230 kHz and must be enabled when PWM is enabled.

It is possible to make the internal oscillator signal available on pin OSCCLK by using the oscillator-control command (see [Table 10](#)) and configuring the clock output enable (COE) bit. If not required, the pin OSCCLK should be left open or connected to V<sub>SS</sub>. At power-on the signal at pin OSCCLK is disabled and pin OSCCLK is in 3-state.

Clock output is only valid when using the internal oscillator. The signal will appear on the OSCCLK pin.

An intermediate clock frequency is available at the OSCCLK pin. The duty cycle of this clock varies with the chosen divide ratio.

Table 14. OSCCLK table

PD	OSC	COE	EFR	OSCCLK pin <sup>[1]</sup>
power-down	n.a.	off	n.a.	3-state <sup>[2]</sup>
power-down	n.a.	on	n.a.	V <sub>DD</sub>
power-up	internal oscillator	off	n.a.	3-state
		on	n.a.	9.6 kHz output <sup>[3]</sup>
	external oscillator	n.a.	9.6 kHz	9.6 kHz input
			230 kHz	230 kHz input

[1] When RESET is active, the internal oscillator is off.

[2] In this state, an external clock may be applied, but it is not a requirement.

[3] 9.6 kHz is the nominal frequency with q = 24, see [Table 15](#).

1. When RESET is active, the pin OSCCLK is in 3-state.

#### External clock

In applications where an external clock must be applied to the PCA8536, bit OSC (see [Table 10](#)) has to be set logic 1. In this case pin OSCCLK becomes an input.

The OSCCLK signal must switch between the V<sub>SS</sub> and the V<sub>DD</sub> voltage supplied to the chip.

The system is designed for a 230 kHz clock or alternatively for using a 9.6 kHz clock. The EFR bit determines the external clock frequency. The clock frequency (f<sub>clk(ext)</sub>) in turn determines the LCD frame frequency, see [Table 15](#).

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The PWM generator requires a 230 kHz clock to operate. If PWM is enabled and an external clock of 9.6 kHz is selected, then the internal oscillator will automatically start and be used for the PWM signal generation.

**Remark:** If an external clock is used, then this clock signal must always be supplied to the device when the display is on. Removing the clock may freeze the LCD in a DC state which will damage the LCD material.

### 7.1.5.2 Timing and frame frequency

The timing of the PCA8536 organizes the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. The timing also generates the LCD frame frequency which it derives as an integer division of the clock frequency (see [Table 15](#)). The frame frequency is a fixed division of the internal clock or of the frequency applied to pin OSCCLK when an external clock is used.

**Table 15. LCD frame frequencies**

Frame frequency	Typical external frequency (Hz)	Nominal frame frequency (Hz)	EFR bit	Value of q <sup>[1]</sup>
$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48}$	9 600	200	0	-
$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48q}$	230 000	200	1	24

[1] Other values of the frame frequency prescaler see [Table 21](#).

When the internal clock is used, or an external clock with EFR = 1, the LCD frame frequency can be programmed by software in steps of approximately 10 Hz in the range of 60 Hz to 300 Hz (see [Table 21](#)). Furthermore the internal oscillator is factory calibrated, see [Table 44](#).

### 7.1.6 Command: GPO-output-config

The behavior of the combined LCD and GPO outputs S5/GP5 to S0/GP0 is configured with the bits described in [Table 16](#).

**Table 16. GPO-output-config - output mode config command for S5/GP5 to S0/GP0**

Bit	Symbol	Value	Description
<b>GPM0 and GPM1</b>			
7 to 4	-	1100	fixed value
3 to 2	GPM1[1:0]	see <a href="#">Table 17</a>	output mode for S1/GP1
1 to 0	GPM0[1:0]	see <a href="#">Table 17</a>	output mode for S0/GP0
<b>GPM2 and GPM3</b>			
7 to 4	-	1101	fixed value
3 to 2	GPM3[1:0]	see <a href="#">Table 17</a>	output mode for S3/GP3
1 to 0	GPM2[1:0]	see <a href="#">Table 17</a>	output mode for S2/GP2
<b>GPM4 and GPM5</b>			
7 to 4	-	1110	fixed value
3 to 2	GPM5[1:0]	see <a href="#">Table 17</a>	output mode for S5/GP5

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 16. GPO-output-config - output mode config command for S5/GP5 to S0/GP0...continued

Bit	Symbol	Value	Description
1 to 0	GPM4[1:0]	see <a href="#">Table 17</a>	output mode for S4/GP4

Each output can be individually configured to be either an LCD segment output, a PWM output or a static general-purpose output (GPO), see [Table 17](#).

**Remark:** Even if using GPO only,  $V_{LCD}$  must still be applied to the device.

Table 17. GPMO mode definition

GPM0[1:0] to GPM5[1:0]	Mode	Description
00 <sup>[1]</sup> , 01	LCD	output is an LCD segment
10	static	output is static GPO
11	PWM	output is PWM GPO

[1] Default value.

### 7.1.7 Command: set-MUX-mode

The multiplex drive mode is configured with the bits described in [Table 18](#).

Table 18. Set-MUX-mode - set multiplex drive mode command bit description

Bit	Symbol	Value	Description
7 to 2	-	0000 00	fixed value
1 to 0	M[1:0]	00 <sup>[1]</sup> , 01	1:8 multiplex drive mode; eight backplanes
		10	1:6 multiplex drive mode; 6 backplanes
		11	1:4 multiplex drive mode; 4 backplanes

[1] Default value.

### 7.1.8 Command: set-bias-mode

The set-bias-mode command allows setting the bias level.

Table 19. Set-bias-mode - set bias mode command bit description

Bit	Symbol	Value	Description
7 to 2	-	0000 01	fixed value
1 to 0	B[1:0]	00 <sup>[1]</sup> , 01	$\frac{1}{4}$ bias
		11	$\frac{1}{3}$ bias
		10	$\frac{1}{2}$ bias

[1] Default value.

### 7.1.9 Command: frame-frequency-LCD

With the frame-frequency-LCD command, the frame frequency for the display can be configured. The clock frequency determines the frame frequency.



## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 20. Frame-frequency-LCD - frame frequency and output clock frequency command bit description

Bit	Symbol	Value	Description
7 to 5	-	001	fixed value
4 to 0	FD[4:0]	see <a href="#">Table 21</a>	frequency prescaler

The system is designed for a 230 kHz clock. It is either internally generated or externally provided. Alternatively a 9.6 kHz clock signal can be provided as well. The EFR bit (see [Table 10](#)) has to be set according to the external clock frequency.

When EFR is set to 9.6 kHz, then the LCD frame frequency is calculated with [Equation 1](#):

$$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48} \quad (1)$$

When EFR is set to 230 kHz, then the LCD frame frequency is calculated with [Equation 2](#):

$$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48q} \quad (2)$$

where q is the frequency divide factor (see [Table 21](#)).

**Remark:**  $f_{clk(ext)}$  is the external input clock frequency to pin OSCCLK.

When the internal oscillator is used, the intermediate frequency may be output on the OSCCLK pin. Its frequency is given in [Table 21](#).

Table 21. Frame frequency prescaler values for 230 kHz clock operation

FD[4:0]	Nominal LCD frame frequency (Hz) <sup>[1]</sup>	Divide factor, q	Intermediate clock frequency (Hz)
0 0000	59.9	80	2 875
0 0001	70.5	68	3 382
0 0010	79.9	60	3 833
0 0011	90.4	53	4 340
0 0100	99.8	48	4 792
0 0101	108.9	44	5 227
0 0110	119.8	40	5 750
0 0111	129.5	37	6 216
0 1000	140.9	34	6 765
0 1001	149.7	32	7 188
0 1010	159.7	30	7 667
0 1011	171.1	28	8 214
0 1100	177.5	27	8 519
0 1101	191.7	25	9 200
0 1110 <sup>[2]</sup>	199.7	24	9 583
0 1111	208.3	23	10 000
1 0000	217.8	22	10 455

Table 21. Frame frequency prescaler values for 230 kHz clock operation...continued

FD[4:0]	Nominal LCD frame frequency (Hz) <sup>[1]</sup>	Divide factor, q	Intermediate clock frequency (Hz)
1 0001	228.3	21	10 952
1 0010	239.6	20	11 500
1 0011	252.2	19	12 105
1 0100	266.2	18	12 778
1 0101	281.9	17	13 529
1 0110	299.5	16	14 375
1 0111 to 1 1111	not used		

[1] Nominal frame frequency calculated for the default clock frequency of 230 kHz.

[2] Default value.

### 7.1.10 Command: frame-frequency-PWM

With the frame-frequency-PWM command, the frame frequency for the PWM signal can be set.

The PWM system requires a clock of 230 kHz either internally generated or externally supplied. Using a slower clock may result in visible flickering of LEDs driven with the PWM signal.

When EFR is set to 230 kHz, then the PWM frame frequency will be calculated with [Equation 3](#):

$$f_{PWM} = \frac{f_{clk(ext)}}{128p} \quad (3)$$

where p is the frequency divide factor (see [Table 23](#)).

Table 22. Frame-frequency-PWM - PWM frame frequency command bit description

Bit	Symbol	Value	Description
7 to 4	-	0100	fixed value
3 to 0	FP[3:0]	see <a href="#">Table 23</a>	frequency prescaler

Table 23. PWM frame frequency prescaler values for 230 kHz clock operation

FP[3:0]	Nominal PWM frame frequency (Hz) <sup>[1]</sup>	Divide factor, p
0000	59.9	30
0001	69.1	26
0010	81.7	22
0011	89.8	20
0100	99.8	18
0101	112.3	16
0110	119.8	15
0111 <sup>[2]</sup>	128.3	14

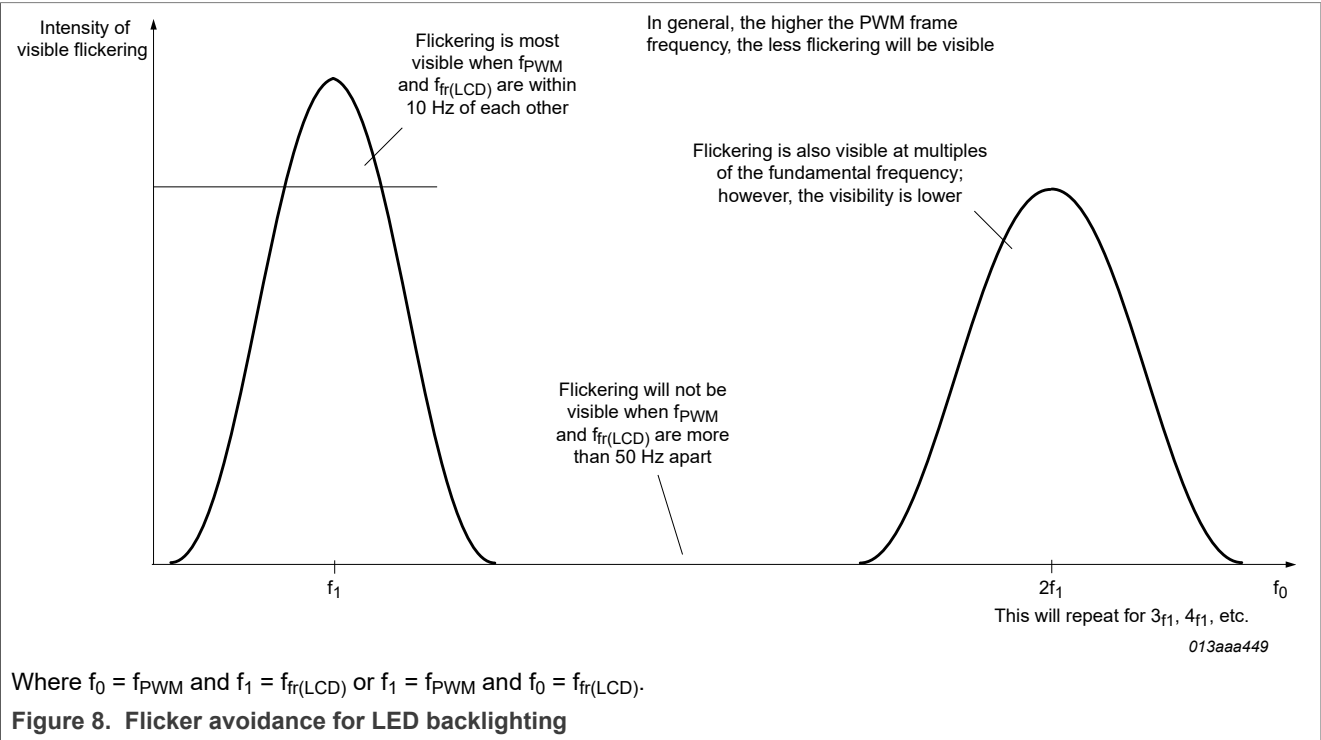
Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 23. PWM frame frequency prescaler values for 230 kHz clock operation...continued

FP[3:0]	Nominal PWM frame frequency (Hz) <sup>[1]</sup>	Divide factor, p
1000	138.2	13
1001	149.7	12
1010	163.4	11
1011	179.7	10
1100	199.7	9
1101	224.6	8
1110	256.7	7
1111	299.5	6

[1] Nominal frame frequency calculated for the default clock frequency of 230 kHz.  
[2] Default value.

In order to avoid flickering caused by the interaction of the backlight LED and the LCD frame frequency, the PWM frame frequency should be programmed to be more than 50 Hz different from LCD frame frequency or multiples of the LCD frame frequency (see [Figure 8](#) and [Table 49 on page 68](#)).



7.1.11 Command: GPO-static-data

When static GPOs are selected instead of PWM, then the value for the output is taken from these register bits. The output is a static level.



Filling of the display RAM is described in [Section 7.9](#).

### 7.1.13 Command: load-data-pointer-PWM

The load-data-pointer-PWM command defines one of the 6 PWM addresses.

**Table 26. Load-data-pointer-PWM - load data pointer command bit description**

Bit	Symbol	Value	Description
7 to 3	-	0111 0	fixed value
2 to 0	PP[2:0]	000 <sup>[1]</sup> to 101	3-bit binary value of 0 to 5

[1] Default value.

**Remark:** Data pointer values outside of the valid range will be ignored and no PWM content will be transferred until a valid data pointer value is set.

### 7.1.14 Command: write-RAM-data

This command will initiate the transfer of data to the display RAM. Data will be written into the address defined by the load-data-pointer-LCD command. RAM filling is described in [Section 7.9](#).

**Table 27. Write-RAM-data - write RAM data command bit description<sup>[1]</sup>**

Bit	Symbol	Value	Description
7 to 0	D[7:0]	0000 0000 to 1111 1111 <sup>[2]</sup>	writing data byte-wise to RAM

[1] For this command to be effective bit RS[1:0] of the control byte has to be set logic 01, see [Table 36](#) page 46.

[2] After Power-On Reset (POR), the RAM content is random and should be brought to a defined status by writing meaningful content otherwise unexpected display content may appear.

### 7.1.15 Command: write-PWM-data

This command will initiate the transfer of data to the PWM registers. Data will be written into the address defined by the load-data-pointer-PWM command. PWM register filling is described in [Section 7.10](#)

**Table 28. Write-PWM-data - write PWM data command bit description<sup>[1]</sup>**

Bit	Symbol	Value	Description
7	-	0	fixed value
6 to 0	P[6:0]	000 0000 <sup>[2]</sup> to 111 1111	writing data byte-wise to PWM registers

[1] For this command to be effective bit RS[1:0] of the control byte has to be set logic 10, see [Table 36](#) page 46.

[2] Default value. After Power-On Reset (POR) the PWM content is set to 0.

## 7.2 Start-up and shut-down

### 7.2.1 Reset and Power-On Reset (POR)

After a reset and at power-on the PCA8536 resets to starting conditions as follows:

1. The display is disabled.

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2. All backplane outputs are set to  $V_{SS}$ .
3. All segment outputs are set to  $V_{SS}$ .
4. All GPO outputs are disabled.
5. Selected drive mode is: 1:8 with  $\frac{1}{4}$  bias.
6. The data pointers are cleared (set logic 0).
7. PWM values are all reset to zero.
8. RAM data is not initialized. Its content can be considered to be random.
9. The internal oscillator is running; no clock signal is available on pin OSCCLK; pin OSCCLK is in 3-state.

The reset state is as shown in [Table 29](#).

**Table 29. Reset state**

Reset state of configurable bits shown in the command table format for clarity.

Associated command	Bits							
	7	6	5	4	3	2	1	0
PWM-inversion								PWMI = 0
mode-settings	-	-	-	-	BPS = 0	INV = 0	PD = 0	E = 0
oscillator-control	-	-	-	-	-	EFR = 0	COE = 0	OSC = 0
GPO-output-config	-	-	-	-	GPM1[1:0] = 00		GPM0[1:0] = 00	
	-	-	-	-	GPM3[1:0] = 00		GPM2[1:0] = 00	
	-	-	-	-	GPM5[1:0] = 00		GPM4[1:0] = 00	
set-MUX-mode	-	-	-	-	-	-	M[1:0] = 00	
set-bias-mode	-	-	-	-	-	-	B[1:0] = 00	
frame-frequency-LCD	-	-	-	FD[4:0] = 0 1110				
frame-frequency-PWM	-	-	-	-	FP[3:0] = 0111			
GPO-static-data	-	-	-	-	-	GPO2 = 0	GPO1 = 0	GPO0 = 0
	-	-	-	-	-	GPO5 = 0	GPO4 = 0	GPO3 = 0
load-data-pointer-LCD	-	-	DP[5:0] = 00 0000					
load-data-pointer-PWM	-	-	-	-	-	PP[2:0] = 000		

The first command sent to the device after the power-on event must be the initialize command (see [Section 7.1.1](#)).

After Power-On Reset (POR) and before enabling the display, the RAM content should be brought to a defined state by writing meaningful content (e.g. a graphic) otherwise unwanted display artifacts may appear on the display.

## 7.2.2 RESET pin function

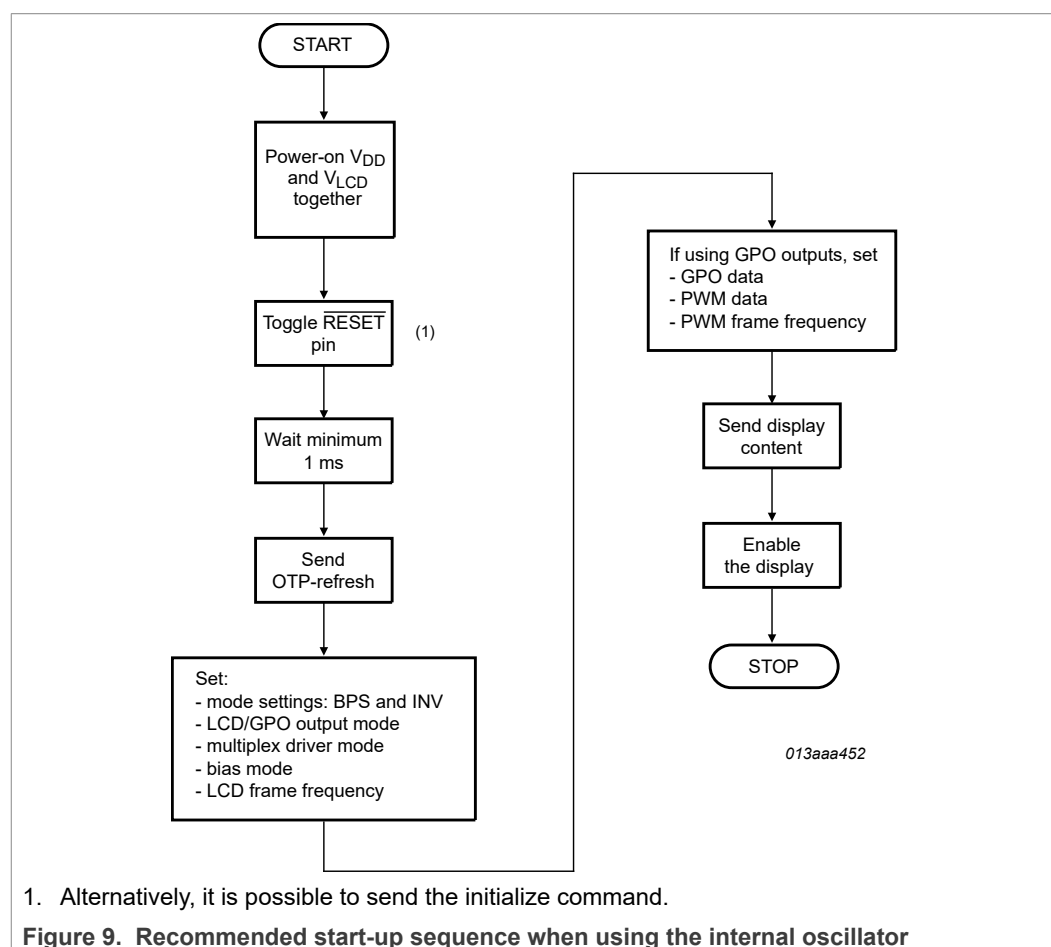
The  $\overline{\text{RESET}}$  pin of the PCA8536 will reset all the registers to their default state. The reset state is given in [Table 29](#). The RAM contents will remain unchanged. After the reset signal is removed, the PCA8536 will behave in the same manner as after Power-On Reset (POR). See [Section 7.2.1](#) for details.

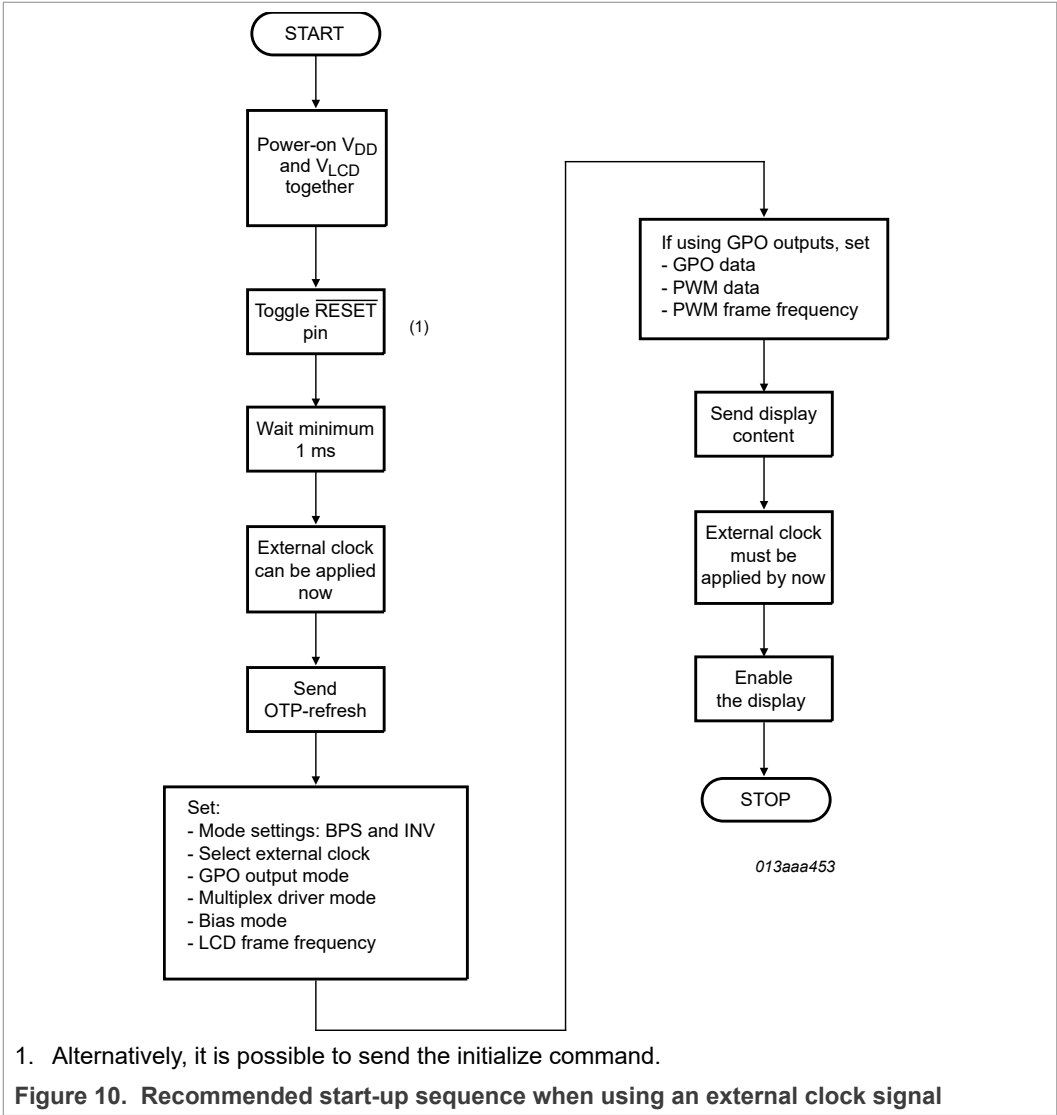
### 7.2.3 Recommended start-up sequences

This chapter describes how to proceed with the initialization of the chip in different application modes.

In general, the sequence should always be:

1. Power-on the device,
2. set the display and functional modes,
3. fill the display memory and then
4. turn on the display.





7.3 Possible display configurations

The PCA8536 is a versatile peripheral device designed to interface between any microcontroller to a wide variety of LCD segment or dot matrix displays (see [Figure 11](#)). It can drive multiplexed LCD with 4, 6, or 8 backplanes and up to 44 segments.

The display configurations possible with the PCA8536 depend on the number of active backplane outputs required. A selection of possible display configurations is given in [Table 30](#).



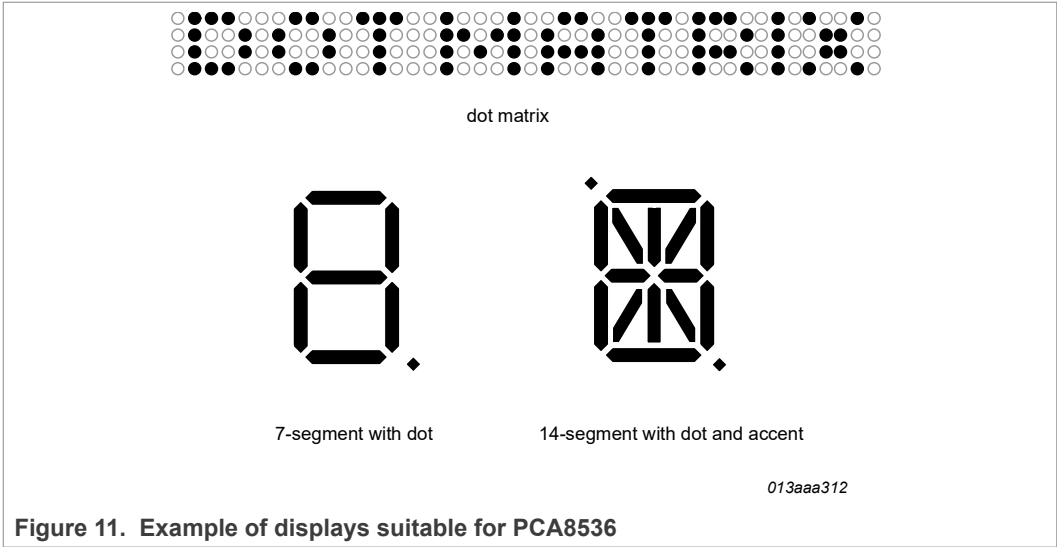


Figure 11. Example of displays suitable for PCA8536

Table 30. Selection of display configurations

Number of			Digits/Characters		Dot matrix/ Elements
Backplanes	Segments	Icons	7 segment <sup>[1]</sup>	14 segment <sup>[2]</sup>	
No GPO or PWM outputs enabled					
8	40	320	40	20	320
6	42	252	31	15	252
4	44	176	22	11	176
With 6 GPO or PWM outputs enabled					
8	34	272	34	17	272
6	36	216	27	13	216
4	38	152	19	9	152

[1] 7 segment display has 8 elements including the decimal point.  
[2] 14 segment display has 16 elements including decimal point and accent dot.

All of the display configurations in [Table 30](#) can be implemented in the typical systems shown in [Figure 12](#) and [Figure 13](#).

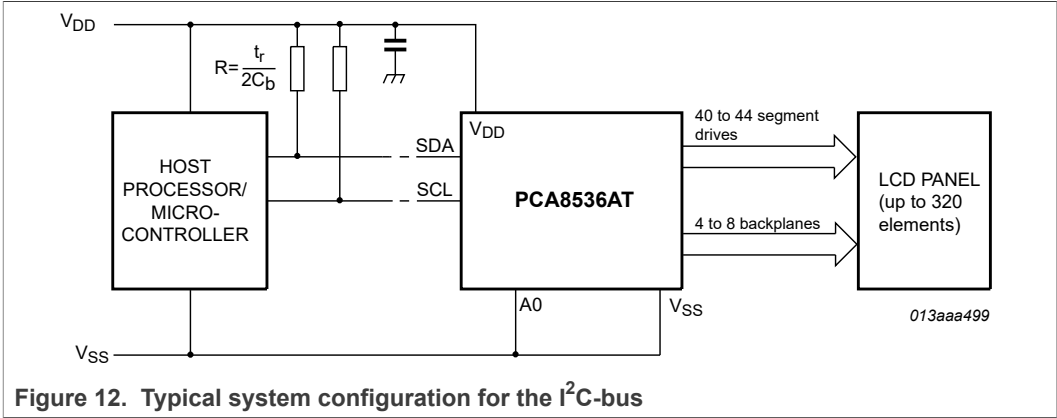
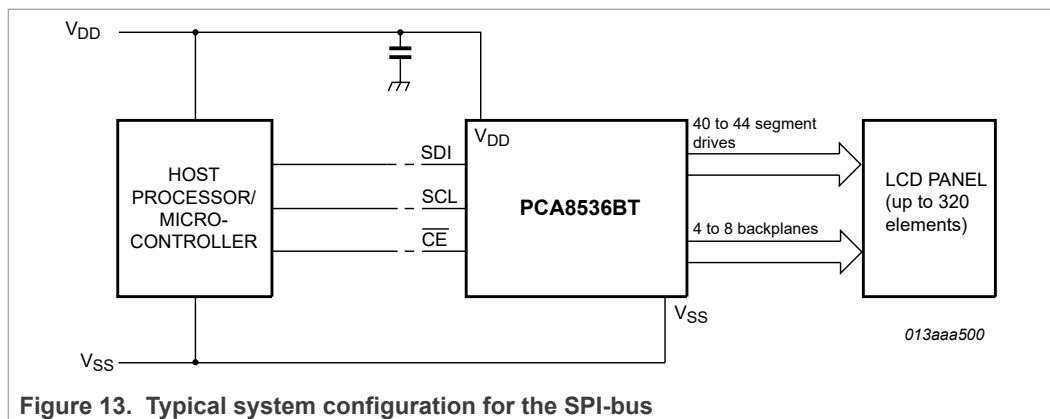


Figure 12. Typical system configuration for the I²C-bus



The host microcontroller maintains the two line I<sup>2</sup>C-bus or a three line SPI-bus communication channel with the PCA8536. The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies ( $V_{DD}$ ,  $V_{SS}$ ,  $V_{LCD}$ ) and the LCD panel selected for the application.

The minimum recommended values for external capacitors on  $V_{DD}$  and  $V_{LCD}$  are 100 nF respectively. Decoupling of  $V_{LCD}$  will help to reduce display artifacts. The decoupling capacitors should be placed close to the IC with short connections to the respective supply pin and  $V_{SS}$ .

## 7.4 LCD voltage selector

The LCD voltage selector co-ordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the set-bias-mode command (see [Table 19](#)) and the set-MUX-mode command (see [Table 18](#)).

Fractional LCD biasing voltages are obtained from an internal voltage divider. The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of  $V_{LCD}$  and the resulting discrimination ratios ( $D$ ), are given in [Table 31](#).

Discrimination is a term which is defined as the ratio of the on and off RMS voltage across a segment. It can be thought of as a measurement of contrast.

**Table 31. Preferred LCD drive modes: summary of characteristics**

LCD multiplex drive mode	Number of:		LCD bias configuration	$\frac{V_{off(RMS)}}{V_{LCD}}$	$\frac{V_{on(RMS)}}{V_{LCD}}$	$D = \frac{V_{on(RMS)}}{V_{off(RMS)}}$ [1]	$V_{LCD}^{[2]}$
	Backplanes	Levels					
1:4 [3]	4	3	$\frac{1}{2}$	0.433	0.661	1.527	$2.309V_{off(RMS)}$
1:4	4	4	$\frac{1}{3}$	0.333	0.577	1.732	$3.0V_{off(RMS)}$
1:4 [3]	4	5	$\frac{1}{4}$	0.331	0.545	1.646	$3.024V_{off(RMS)}$
1:6 [3]	6	3	$\frac{1}{2}$	0.456	0.612	1.341	$2.191V_{off(RMS)}$
1:6	6	4	$\frac{1}{3}$	0.333	0.509	1.527	$3.0V_{off(RMS)}$
1:6	6	5	$\frac{1}{4}$	0.306	0.467	1.527	$3.266V_{off(RMS)}$
1:8 [3]	8	3	$\frac{1}{2}$	0.467	0.586	1.254	$2.138V_{off(RMS)}$
1:8 [3]	8	4	$\frac{1}{3}$	0.333	0.471	1.414	$3.0V_{off(RMS)}$

Table 31. Preferred LCD drive modes: summary of characteristics...continued

LCD multiplex drive mode	Number of:		LCD bias configuration	$\frac{V_{off(RMS)}}{V_{LCD}}$	$\frac{V_{on(RMS)}}{V_{LCD}}$	$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} [1]$	$V_{LCD} [2]$
	Backplanes	Levels					
1:8	8	5	$\frac{1}{4}$	0.293	0.424	1.447	$3.411V_{off(RMS)}$

[1] Determined from Equation 6.

[2] Determined from Equation 5.

[3] In these examples, the discrimination factor and hence the contrast ratios are smaller. The advantage of these LCD drive modes is a reduction of the LCD voltage  $V_{LCD}$ .

A practical value for  $V_{LCD}$  is determined by equating  $V_{off(RMS)}$  with a defined LCD threshold voltage ( $V_{th(off)}$ ), typically when the LCD exhibits approximately 10 % contrast.

Bias is calculated by  $\frac{1}{1+a}$ , where the values for a are

$a = 1$  for  $\frac{1}{2}$  bias

$a = 2$  for  $\frac{1}{3}$  bias

$a = 3$  for  $\frac{1}{4}$  bias

The RMS on-state voltage ( $V_{on(RMS)}$ ) for the LCD is calculated with Equation 4

$$V_{on(RMS)} = \frac{V_{LCD}}{n} \sqrt{\frac{a^2 + 2a + n}{(1+a)^2}} \quad (4)$$

where  $V_{LCD}$  is the resultant voltage at the LCD segment and where the values for n are

$n = 4$  for 1:4 multiplex drive

$n = 6$  for 1:6 multiplex drive

$n = 8$  for 1:8 multiplex drive

The RMS off-state voltage ( $V_{off(RMS)}$ ) for the LCD is calculated with Equation 5:

$$V_{off(RMS)} = \frac{V_{LCD}}{n} \sqrt{\frac{a^2 - 2a + n}{(1+a)^2}} \quad (5)$$

Discrimination is the ratio of  $V_{on(RMS)}$  to  $V_{off(RMS)}$  and is determined from Equation 6:

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{a^2 + 2a + n}{a^2 - 2a + n}} \quad (6)$$

It should be noted that  $V_{LCD}$  is sometimes referred to as the LCD operating voltage.

### 7.4.1 Electro-optical performance

Suitable values for  $V_{on(RMS)}$  and  $V_{off(RMS)}$  are dependent on the LCD liquid used. The RMS voltage, at which a pixel will be switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at  $V_{th(off)}$ ) and the other at 90 % relative transmission (at  $V_{th(on)}$ ), see Figure 14. For a good contrast performance, the following rules should be followed:

$$V_{on(RMS)} \geq V_{th(on)} \quad (7)$$

$$V_{off(RMS)} \leq V_{th(off)} \quad (8)$$

$V_{on(RMS)}$  and  $V_{off(RMS)}$  are properties of the display driver and are affected by the selection of a, n (see Equation 4 to Equation 6) and the  $V_{LCD}$  voltage.

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$V_{th(off)}$  and  $V_{th(on)}$  are properties of the LCD liquid and can be provided by the module manufacturer.  $V_{th(off)}$  is sometimes just named  $V_{th}$ .  $V_{th(on)}$  is sometimes named saturation voltage  $V_{sat}$ .

It is important to match the module properties to those of the driver in order to achieve optimum performance.

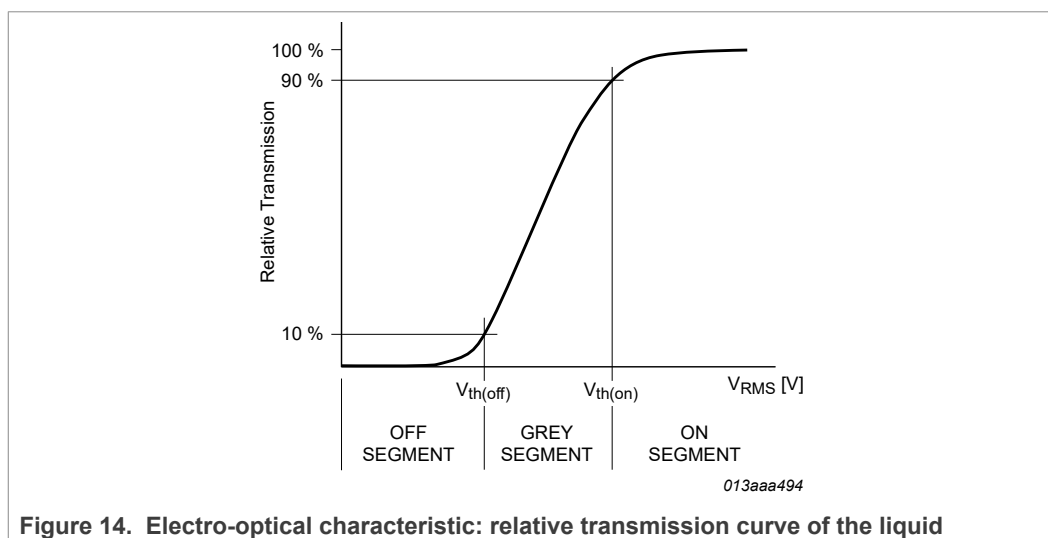
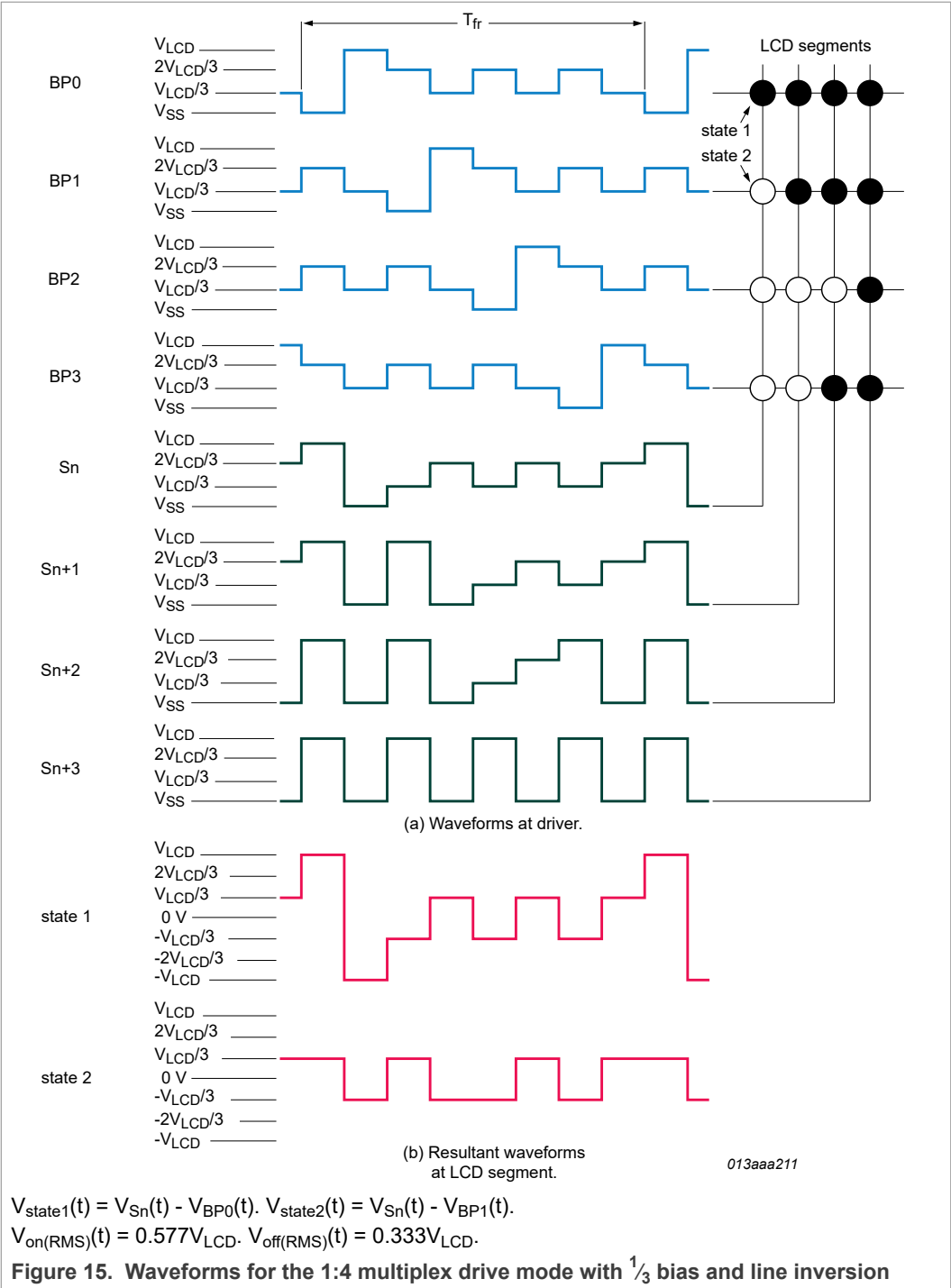


Figure 14. Electro-optical characteristic: relative transmission curve of the liquid

## 7.5 LCD drive mode waveforms

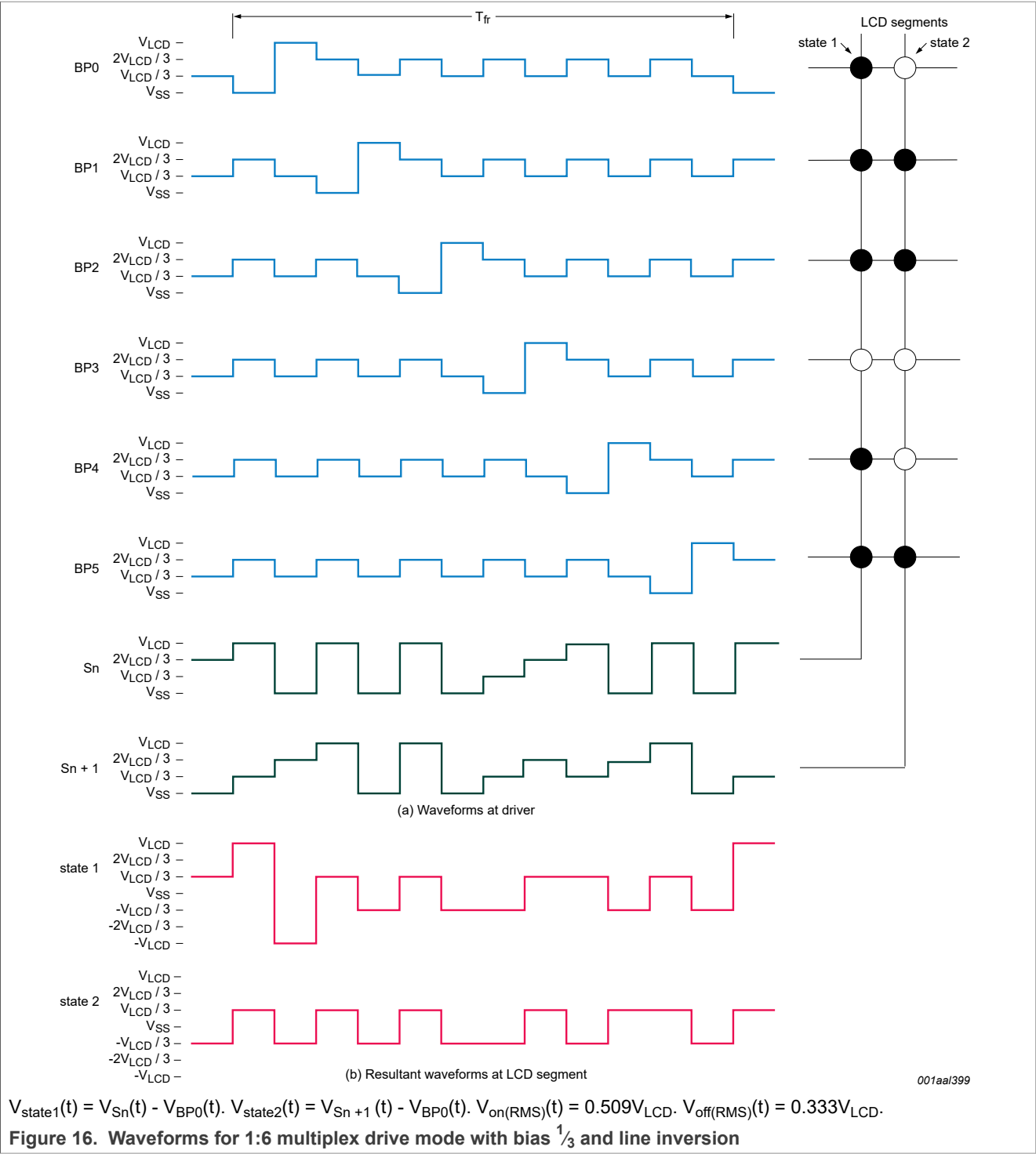
### 7.5.1 1:4 Multiplex drive mode

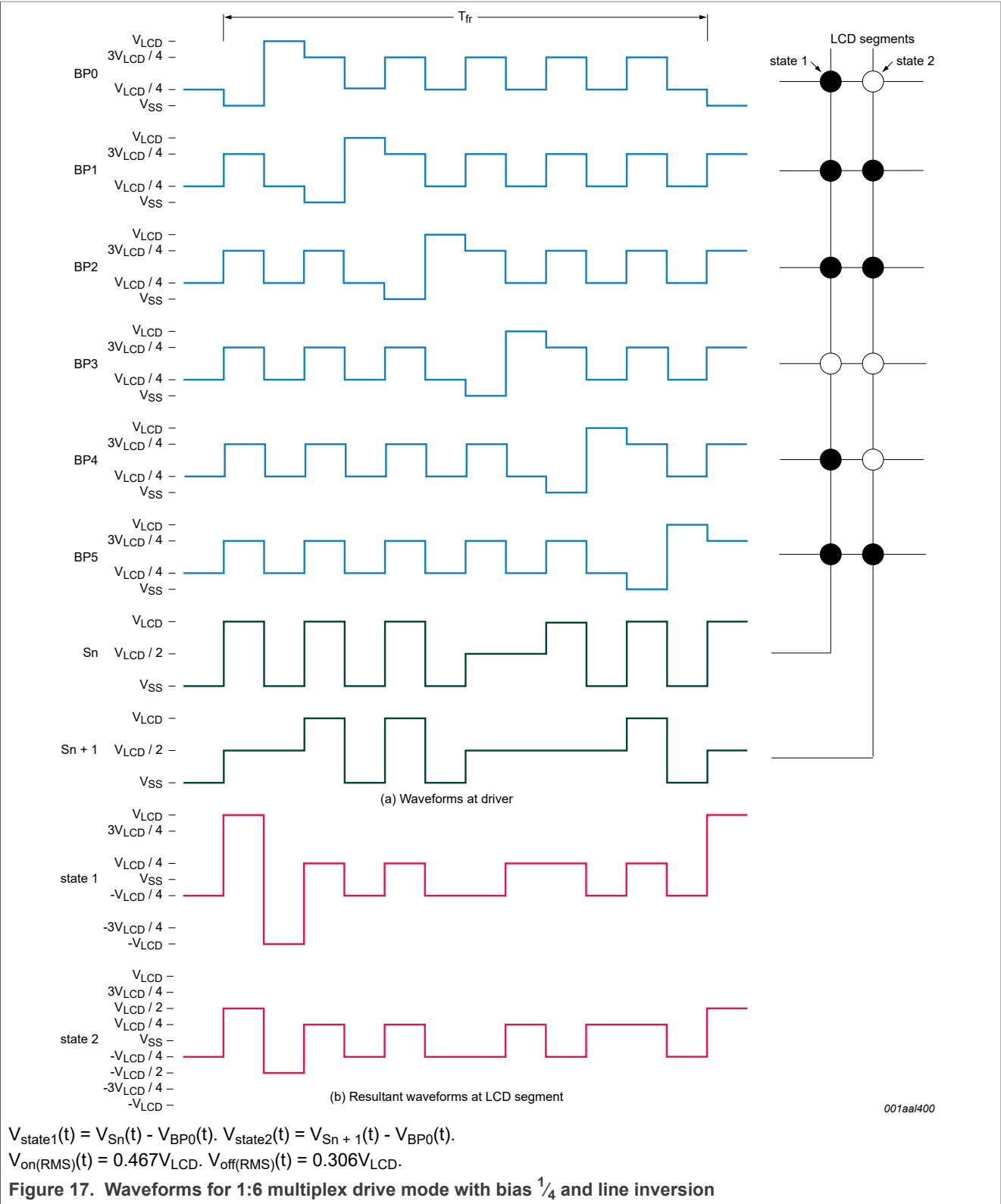
When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies, as shown in [Figure 15](#). This drawing is also showing the case of line inversion (see [Section 7.1.4.2](#)).



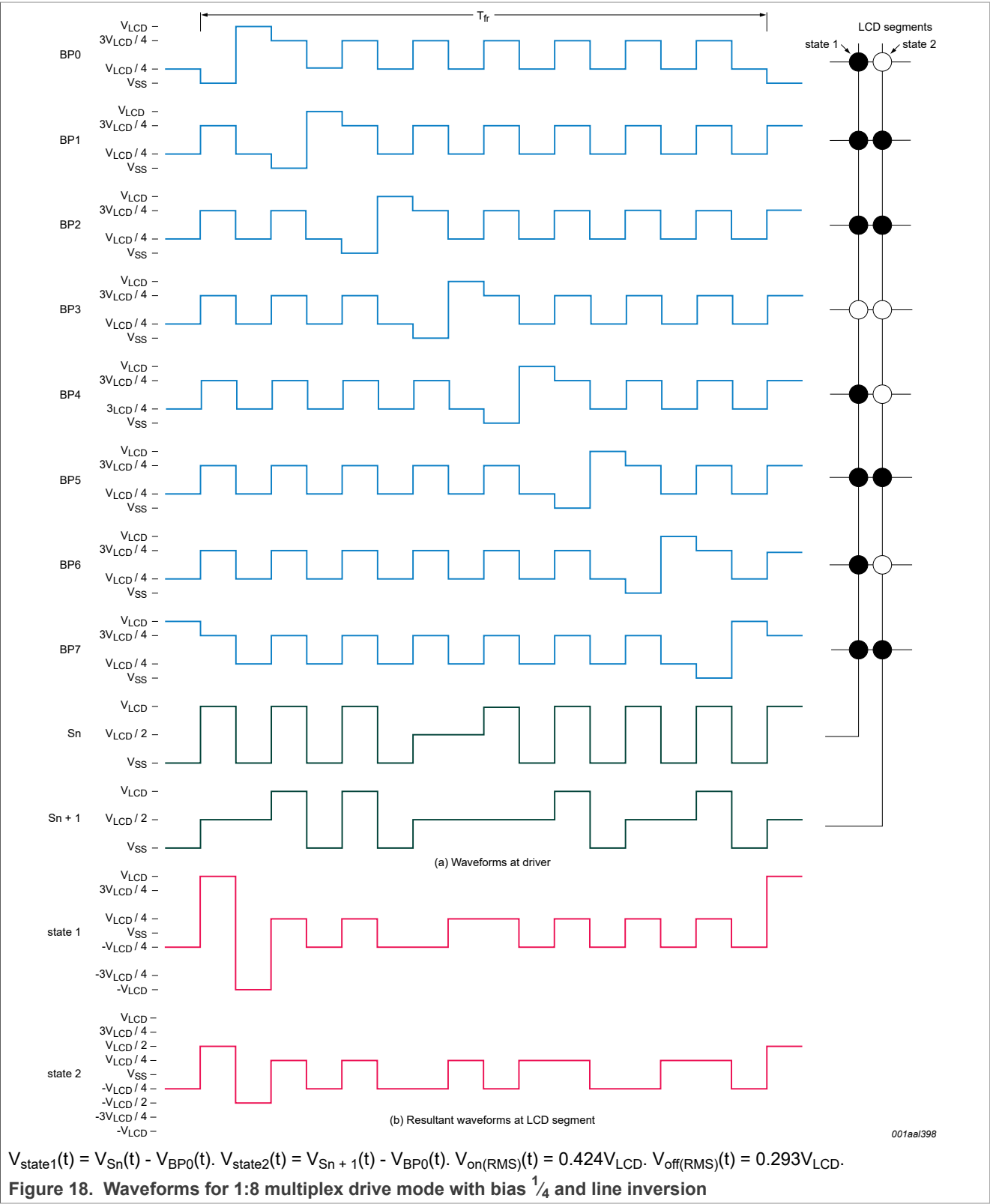
7.5.2 1:6 Multiplex drive mode

When six backplanes are provided in the LCD, the 1:6 multiplex drive mode applies. The PCA8536 allows use of  $\frac{1}{3}$  bias or  $\frac{1}{4}$  bias in this mode as shown in [Figure 16](#) and [Figure 17](#). These waveforms are drawn for the case of line inversion (see [Section 7.1.4.2](#)).

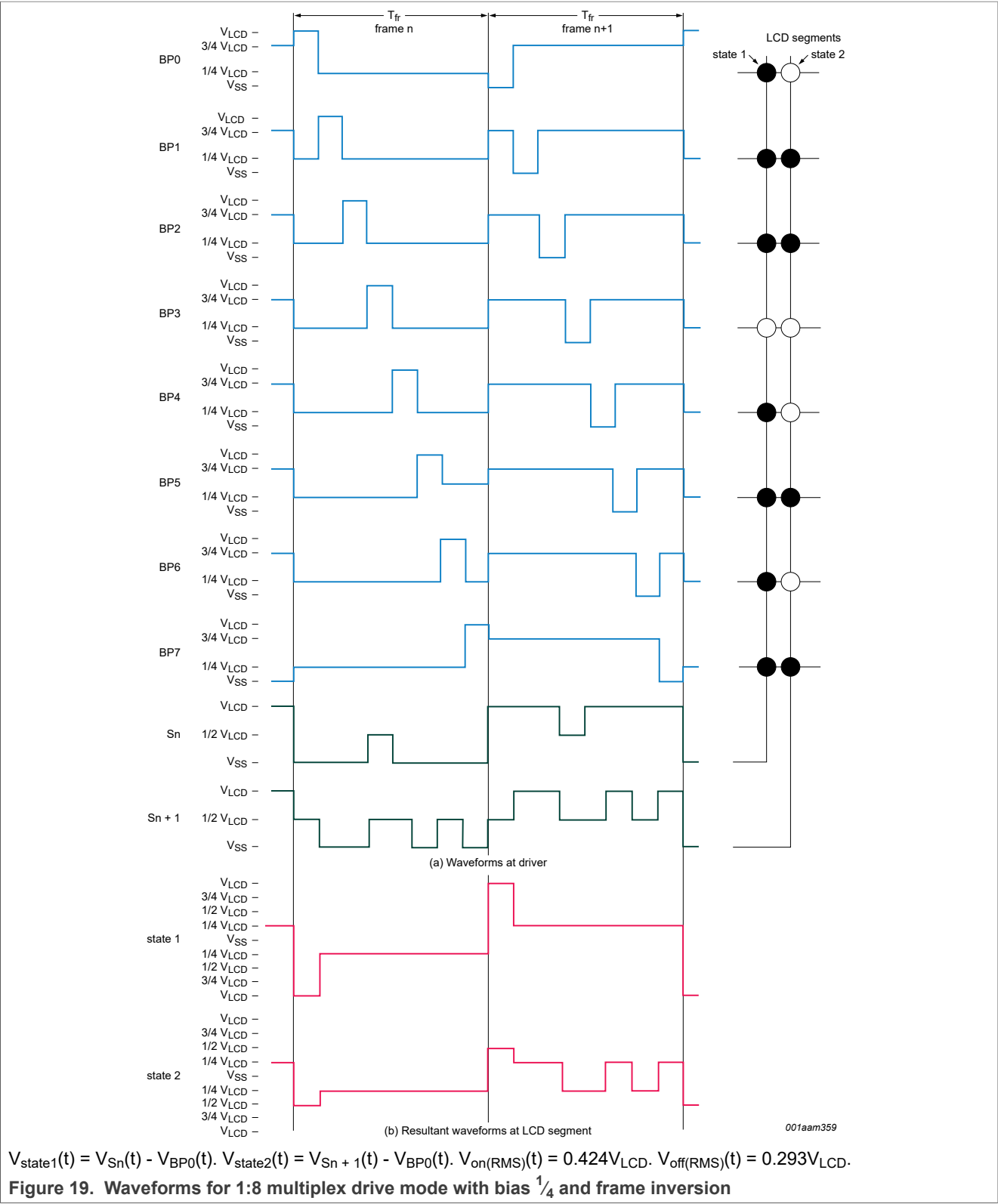




7.5.3 1:8 Multiplex drive mode







## 7.6 Display register

The display register holds the display data while the corresponding multiplex signals are generated.

## 7.7 Backplane outputs

The LCD drive section includes eight backplane outputs: BP0 to BP7. The backplane output signals are generated based on the selected LCD multiplex drive mode.

- In 1:8 multiplex drive mode: BP0 to BP7 must be connected directly to the LCD.
- In 1:6 multiplex drive mode: BP0 to BP5 must be connected directly to the LCD.
- In 1:4 multiplex drive mode: BP0 to BP3 must be connected directly to the LCD.

## 7.8 Segment outputs

The LCD drive section includes up to 44 segment outputs (S0 to S43) which must be connected directly to the LCD. The segment output signals are generated based on the multiplexed backplane signals and with data resident in the display register. When less segment outputs are required, the unused segment outputs must be left open-circuit.

The number of available segments depends on the multiplex drive mode selected and the number of GPOs used. The table shows consecutive GPOs selected, but this is just for simplicity of explanation. Any combination of GPOs may be used.

**Table 32. Backplane and active segment combinations**

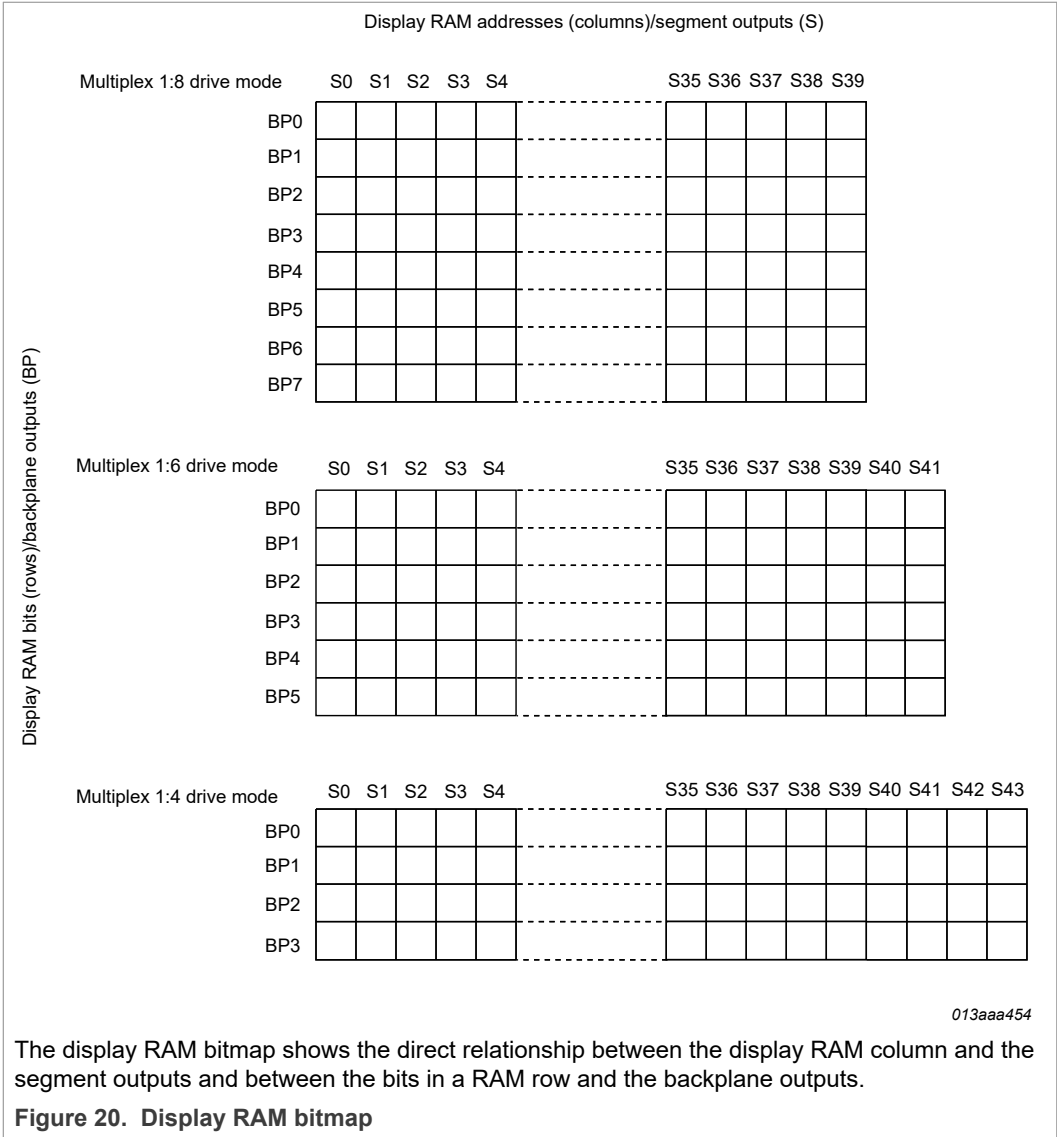
*Basic examples. GPO pins may be configured in any combination. Other LCD segment and GPO combinations are possible.*

Multiplex drive mode	Active BPs	Active GPOs						
		None	GP0 only	GP0 to GP1	GP0 to GP2	GP0 to GP3	GP0 to GP4	GP0 to GP5
1:8	BP0 to BP7	S0 to S39	S1 to S39	S2 to S39	S3 to S39	S4 to S39	S5 to S39	S6 to S39
1:6	BP0 to BP5	S0 to S41	S1 to S41	S2 to S41	S3 to S41	S4 to S41	S5 to S41	S6 to S41
1:4	BP0 to BP3	S0 to S43	S1 to S43	S2 to S43	S3 to S43	S4 to S43	S5 to S43	S6 to S43

## 7.9 Display RAM

The display RAM stores the LCD data. Depending on the multiplex drive mode, the arrangement of the RAM is changed.

- multiplex drive 1:8: RAM is 40 × 8 bit
- multiplex drive 1:6: RAM is 42 × 6 bit
- multiplex drive 1:4: RAM is 44 × 4 bit



Logic 1 in the RAM bit map indicates the on-state ( $V_{on(RMS)}$ ) of the corresponding LCD element; similarly, logic 0 indicates the off-state ( $V_{off(RMS)}$ ). For more information on  $V_{on(RMS)}$  and  $V_{off(RMS)}$ , see [Section 7.4](#).

There is a one-to-one correspondence between

- the bits in the RAM bitmap and the LCD elements,
- the RAM columns and the segment outputs,
- the RAM rows and the backplane outputs.

The display RAM bit map, [Figure 20](#), shows row 0 to row 7 which correspond with the backplane outputs BP0 to BP7, and column 0 to column 43 which correspond with the segment outputs S0 to S43. In multiplexed LCD applications, the data of each row of the display RAM is time-multiplexed with the corresponding backplane (row 0 with BP0, row 1 with BP1, and so on).

When display data is transmitted to the PCA8536, the display bytes received are stored in the display RAM in accordance with the selected LCD multiplex drive mode. The data

is stored as it arrives and depending on the current multiplex drive mode, data is stored in quadruples, sextuples or bytes.

### 7.9.1 Data pointer (LCD part)

The addressing mechanism for the display RAM is realized using the data pointer. This allows the loading of an individual display data byte, or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialization of the data pointer by the load-data-pointer-LCD command (see [Table 25](#)).

Following this command, an arriving data byte is stored starting at the display RAM address indicated by the data pointer.

The data pointer is automatically incremented in accordance with the chosen LCD multiplex drive mode configuration. That is, after each byte is stored, the contents of the data pointer are incremented

- by two (1:4 multiplex drive mode),
- by one or two (1:6 multiplex drive mode),
- by one (1:8 multiplex drive mode).

Multiplex drive 1:6 is a special case and is described later on.

When the address counter reaches the end of the RAM, it stops incrementing after the last byte is transmitted. Redundant bits of the last byte and subsequent bytes transmitted are discarded until the pointer is reset. To send new RAM data, the data pointer must be reset.

If an I<sup>2</sup>C-bus or SPI-bus data access is terminated early then the state of the data pointer is unknown. The data pointer must then be re-written prior to further RAM accesses.

### 7.9.2 RAM filling in 1:4 multiplex drive mode

In the 1:4 multiplex drive mode the RAM is organized in four rows and 44 columns. The eight transmitted data bits are placed in two successive display RAM columns of four rows (see [Figure 21](#)). In order to fill the whole four RAM rows, 22 bytes need to be sent to the PCA8536. After the last byte sent, the data pointer must be reset before the next RAM content update. Additional data bytes sent and any data bits that spill over the RAM will be discarded.

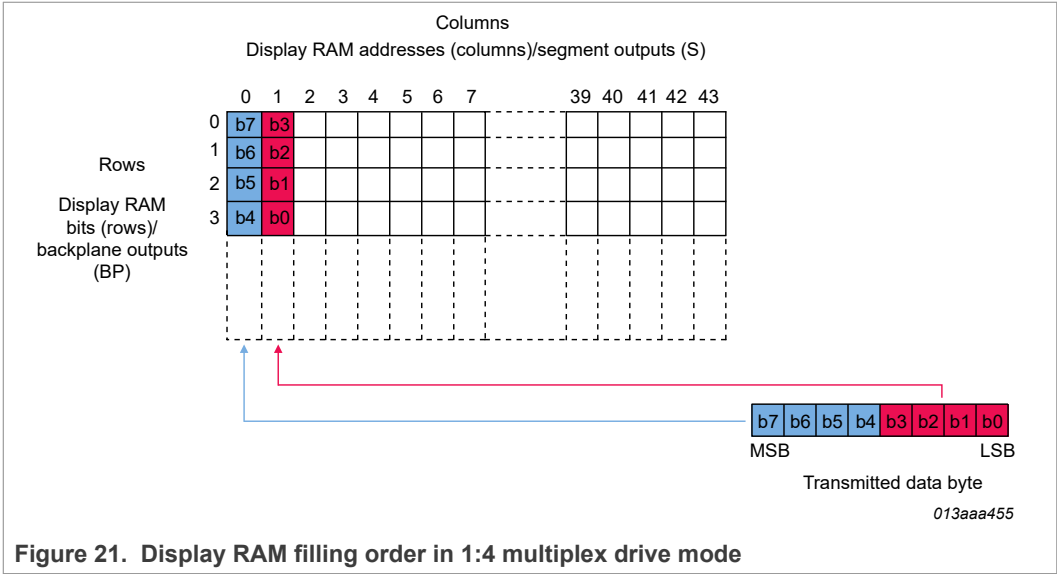


Figure 21. Display RAM filling order in 1:4 multiplex drive mode

Depending on the start address of the data pointer, there is the possibility for a boundary condition. This will occur when more data bits are sent than fit into the remaining RAM. The additional data bits are discarded. See [Figure 22](#).

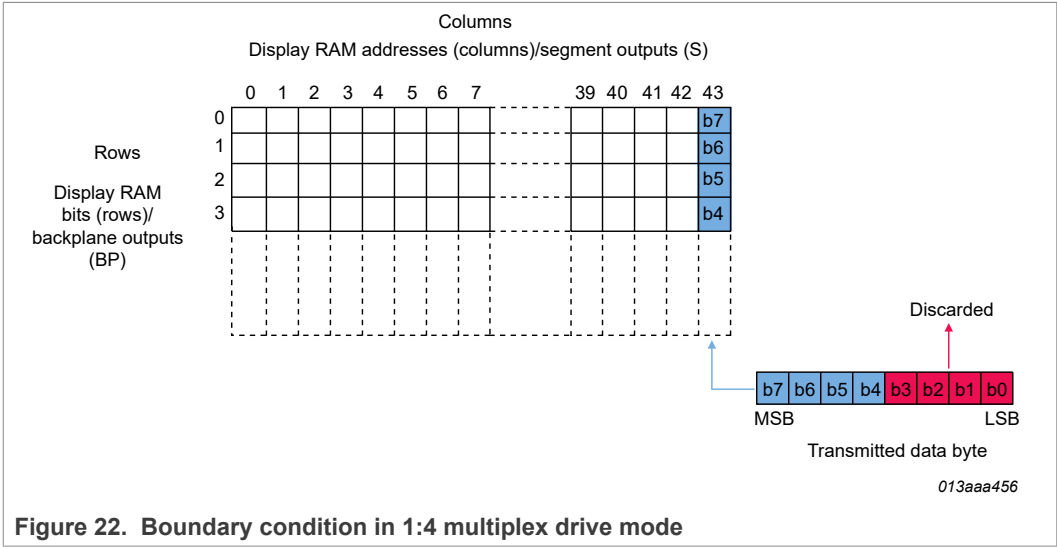
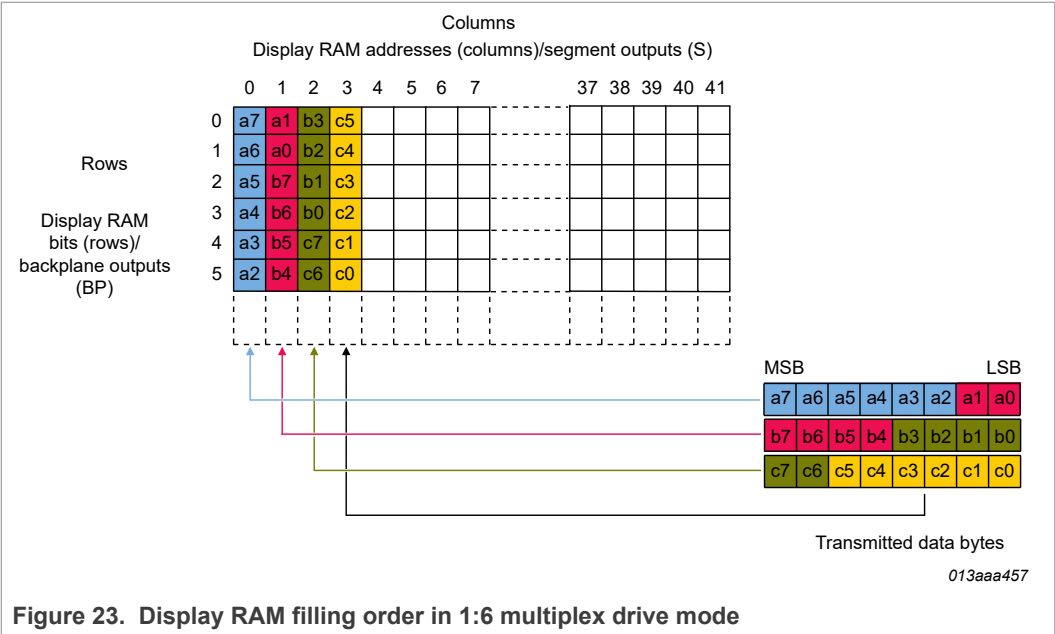


Figure 22. Boundary condition in 1:4 multiplex drive mode

7.9.3 RAM filling in 1:6 multiplex drive mode

In the 1:6 multiplex drive mode the RAM is organized in six rows and 42 columns. The eight transmitted data bits are placed in such a way, that a column is filled up (see [Figure 23](#)).



The remaining bits are wrapped over into the next column. In order to fill the whole RAM, 31 and a half bytes need to be sent to the PCA8536. After the last byte sent, the data pointer must be reset before the next RAM content update. Additional data bytes sent and any data bits that spill over the RAM will be discarded. Depending on the start address of the data pointer, there are three possible boundary conditions. See [Figure 24](#).

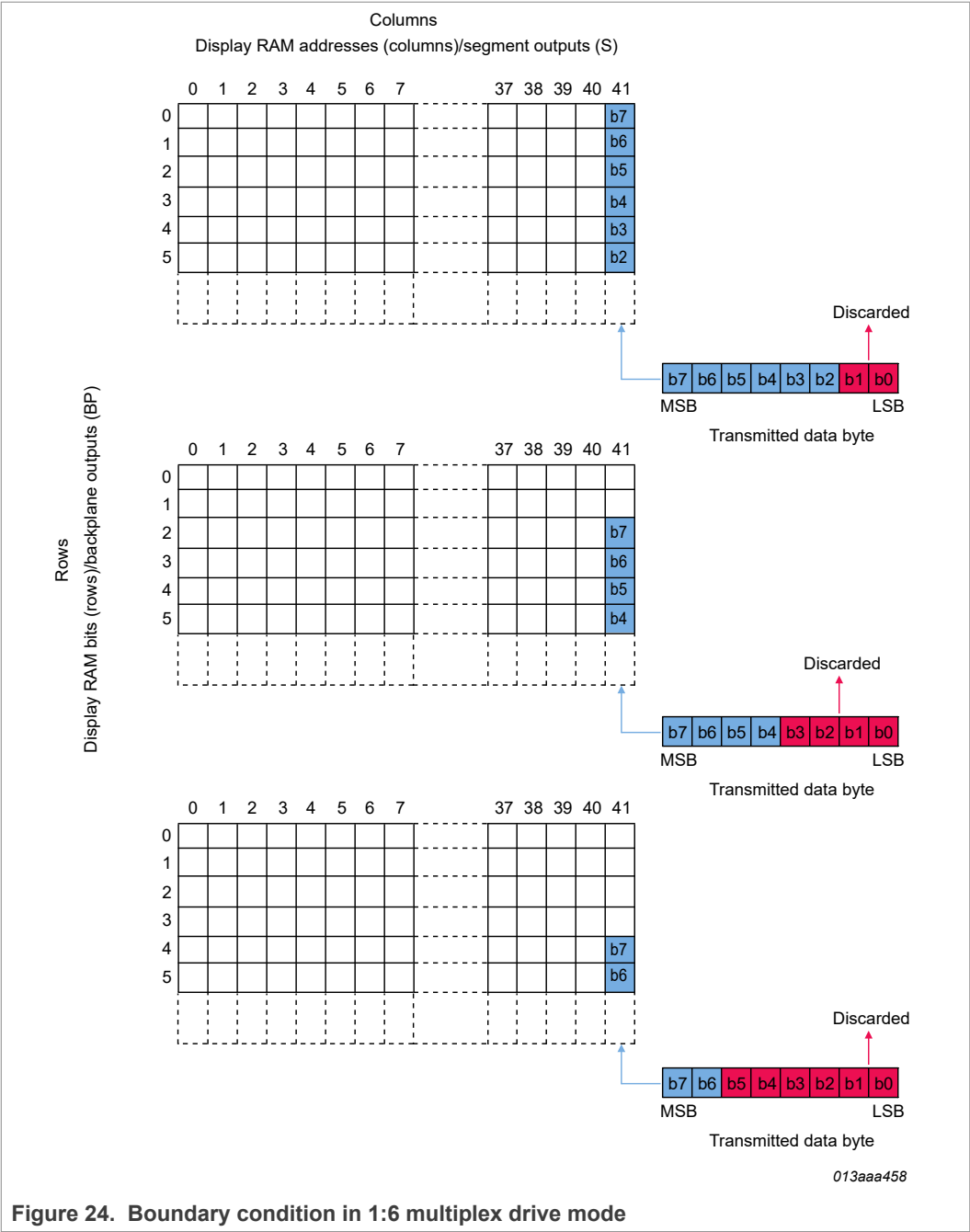
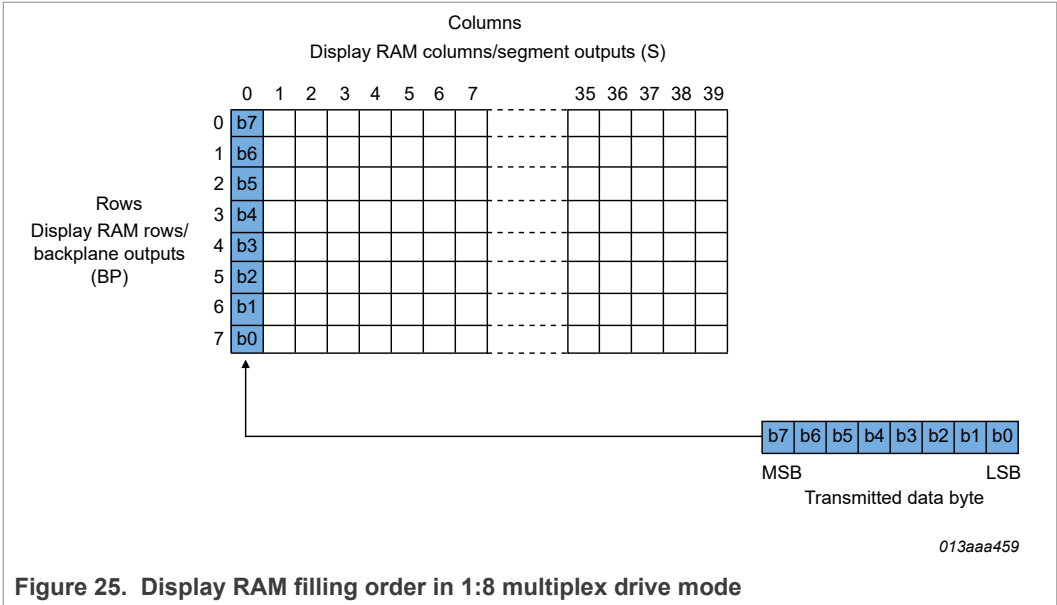


Figure 24. Boundary condition in 1:6 multiplex drive mode

7.9.4 RAM filling in 1:8 multiplex drive mode

In the 1:8 multiplex drive mode the RAM is organized in eight rows and 40 columns. The eight transmitted data bits are placed into eight rows of one display RAM column (see [Figure 25](#)). In order to fill the whole RAM, 40 bytes need to be sent to the PCA8536. After the last byte sent, the data pointer must be reset before the next RAM content update. Additional data bytes sent will be discarded.



There are no boundary conditions in 1:8 multiplex drive mode.

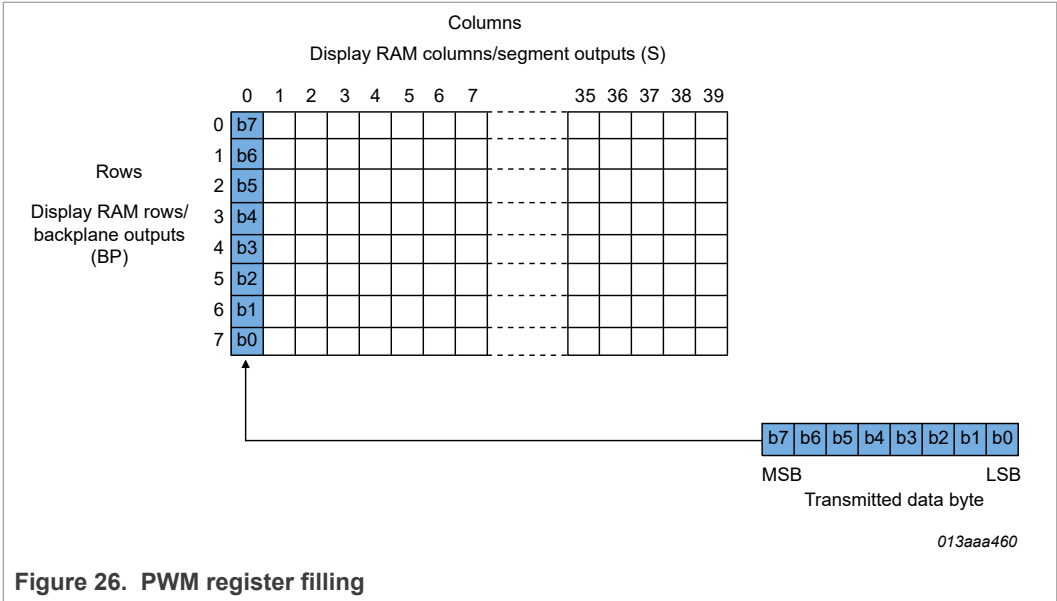
7.10 PWM registers and data pointer (PWM part)

There are six PWM generators which can be independently configured. The values used to define the PWM output are stored here.

The addressing mechanism for the PWM register is realized using the PWM data pointer. This allows the loading of an individual PWM data byte, or a series of data bytes, into any location of the PWM registers. The sequence commences with the initialization of the data pointer by the load-data-pointer-PWM command (see [Table 26](#)).

Following this command, an arriving data byte is stored starting at the PWM register address indicated by the PWM data pointer. The data pointer is automatically incremented. That is, after each byte is stored, the contents of the data pointer are incremented. The data pointer will wrap around continuously as long as data is transmitted.





7.11 GPO output

The PCA8536 contains six independently configured GPO pins (GP0 to GP5). These outputs, when enabled, will replace the function of the corresponding LCD segment outputs.

Each GPO output can supply either a logic 1, a logic 0, or a PWM signal. The PWM signal can be used to control the brightness of an LED.

The PWM generator has 128 possible levels allowing for an output with a variable duty cycle between 0 % and 99.7 %. 100 % can only be achieved by a static 1 output.

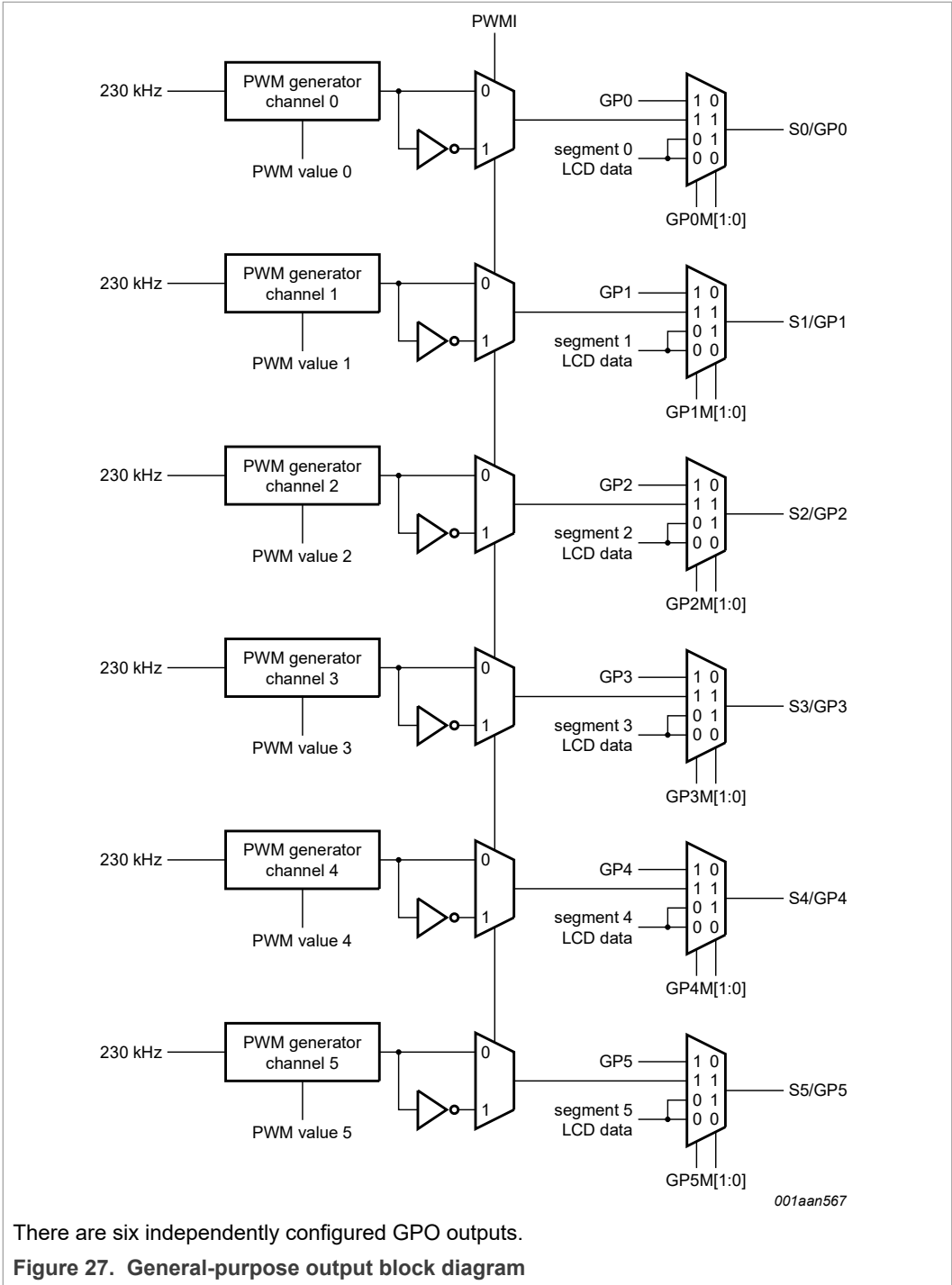
The period of the PWM frame frequency described in [Section 7.1.10](#) is divided into 128 time slots. The value in the PWM register determines for how many of these time slots the PWM output is at logic 1.

Table 33. PWM generator

PWM register value	Percentage of ON time (%)	Time slots at 1	Time slots at 0
0	0	0	128
1	0.78	1	127
2	1.56	2	126
:	:	:	:
126	98.4	126	2
127	99.2	127	1

PWM duty cycle may be calculated by:

$$DutyCycle = \frac{PWMvalue}{128} \cdot 100 \text{ (9)}$$



An example of the PWM waveforms is given in [Figure 28](#).

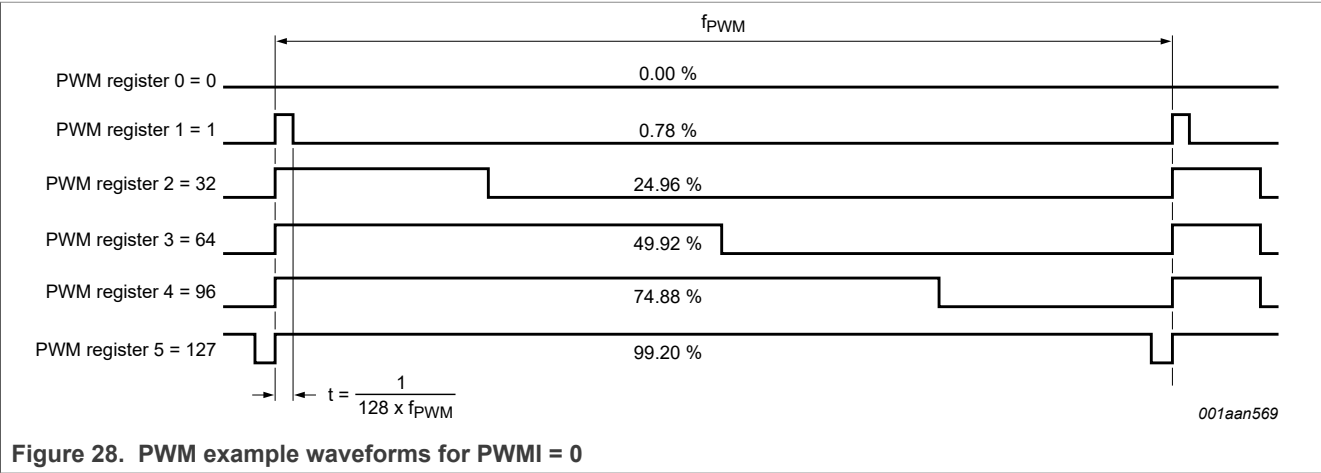


Figure 28. PWM example waveforms for PWMI = 0

7.11.1 RGB color driving

There are six PWM channels that can be arranged as two RGB channels. There are no explicit settings for this feature, only ways of utilizing the PWM channels.

[Table 34](#) gives an example of how two RGB clusters can be configured.

Table 34. Combining PWM channels for RGB

RGB cluster	PWM channel	Component color
0	0	red
	1	green
	2	blue
1	3	red
	4	green
	5	blue

[Figure 29](#) gives an example of how two RGB clusters can be connected.

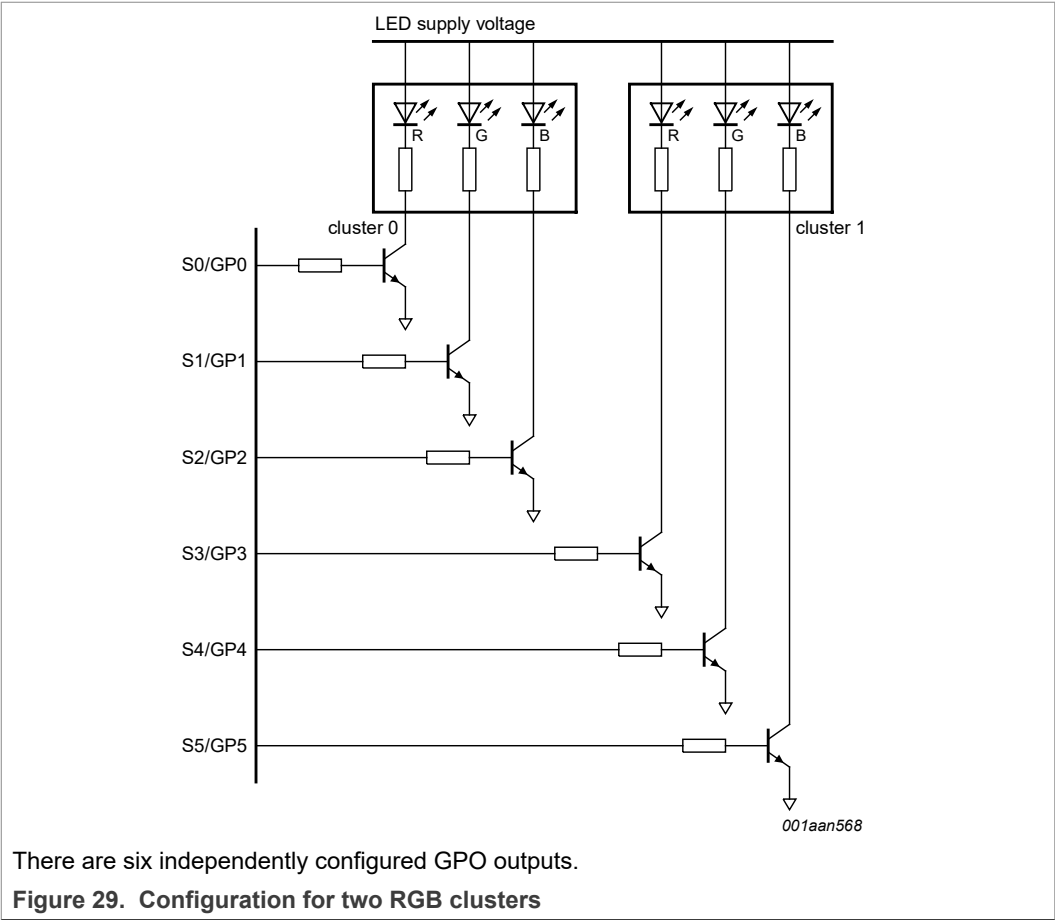


Table 35 gives some examples of programming values for the PWM channels in order to achieve the given colors. By using three PWM channels for one RGB cluster it is possible to generate two million colors.

Table 35. Example PWM values

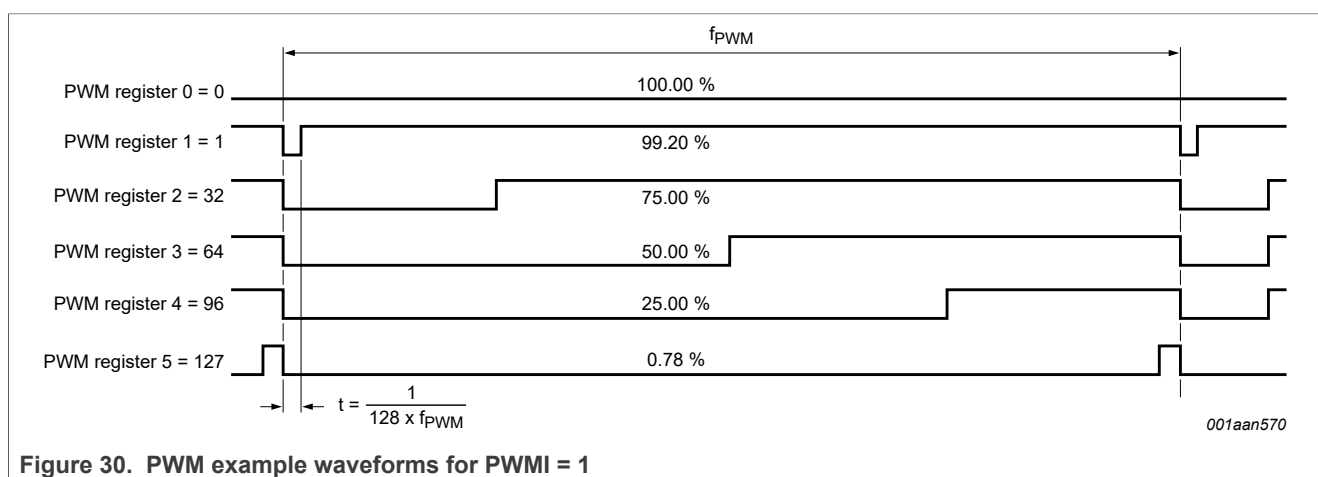
PWM channel	Component color	PWM channel value	Resultant color
0	red	127	yellow
1	green	127	
2	blue	0	
3	red	127	orange
4	green	82	
5	blue	0	
0	red	0	aqua
1	green	127	
2	blue	127	
3	red	127	gold
4	green	108	
5	blue	0	

### 7.11.2 PWM inversion mode

The PWM inversion mode can be enabled by setting the PWMI bit to logic 1 (see [Table 7](#) on page 8). The PWMI mode will invert the PWM waveform.

By default, all PWM outputs will switch HIGH at the same time. If the PWM output is used to drive external LEDs then this could cause a voltage dip on the power supply of the LEDs. With the PWMI mode, it is possible to prevent multiple outputs switching HIGH at the same time by ensuring that the PWM values are not identical.

In the example in [Figure 30](#), none of the six PWM outputs switch HIGH together. All PWM channels instead switch off together; however this will not cause any power supply disturbances.



When PWM inversion mode is used, the PWM duty cycle can be calculated with:

$$DutyCycle = \frac{128 - PWMvalue}{128} \cdot 100 (10)$$

## 8 Bus interfaces

### 8.1 Control byte and register selection

After initiating the communication over the bus and sending the target address (I<sup>2</sup>C-bus, see [Section 8.2](#)) or subaddress (SPI-bus, see [Section 8.3](#)), a control byte follows. The purpose of this byte is to indicate both, the content for the following data bytes (RAM, command, or PWM data) and to indicate that more control bytes will follow.

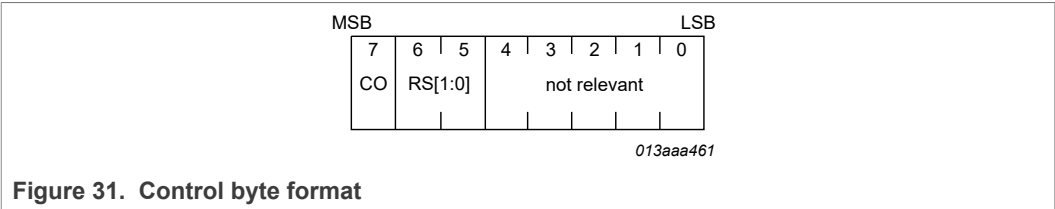
Typical sequences could be:

- target address/subaddress - control byte - command byte - command byte - command byte - end
- target address/subaddress - control byte - RAM byte - RAM byte - RAM byte - end
- target address/subaddress - control byte - command byte - control byte - RAM byte - end

In this way, it is possible to send a mixture of RAM, PWM and command data in one access or alternatively, to send just one type of data in one access.

Table 36. Control byte description

Bit	Symbol	Value	Description
7	CO		<b>continue bit</b>
		0	last control byte
		1	control bytes continue
6 to 5	RS[1:0]		<b>register selection</b>
		00	command register
		01	RAM data
		10	PWM data
		11	unused
4 to 0	-	-	unused

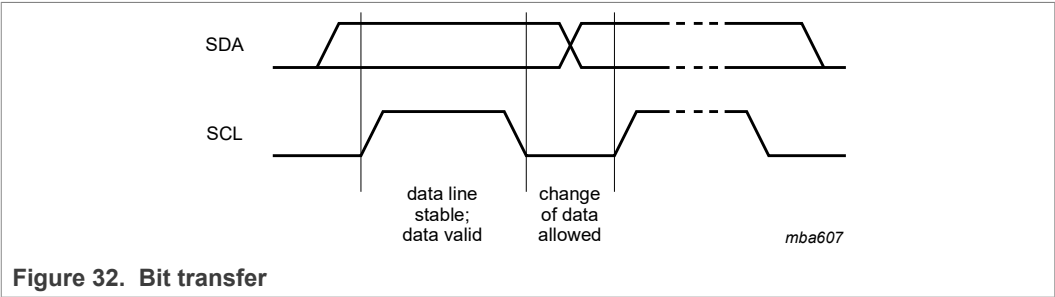


8.2 I<sup>2</sup>C-bus interface

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DATA line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

8.2.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see [Figure 32](#)).



8.2.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.  
A HIGH-to-LOW change of the data line, while the clock is HIGH, is defined as the START condition (S).

A LOW-to-HIGH change of the data line, while the clock is HIGH, is defined as the STOP condition (P).

The START and STOP conditions are shown in [Figure 33](#).

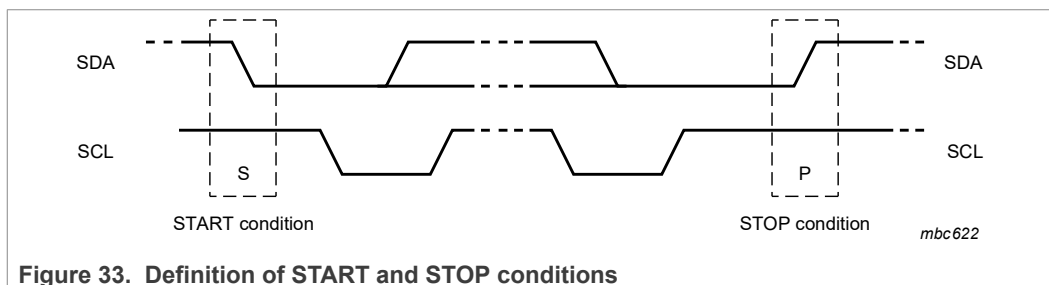


Figure 33. Definition of START and STOP conditions

### 8.2.3 System configuration

A device generating a message is a transmitter, a device receiving a message is the receiver. The device that controls the message is the controller and the devices which are controlled by the controller are the targets. The system configuration is shown in [Figure 34](#).

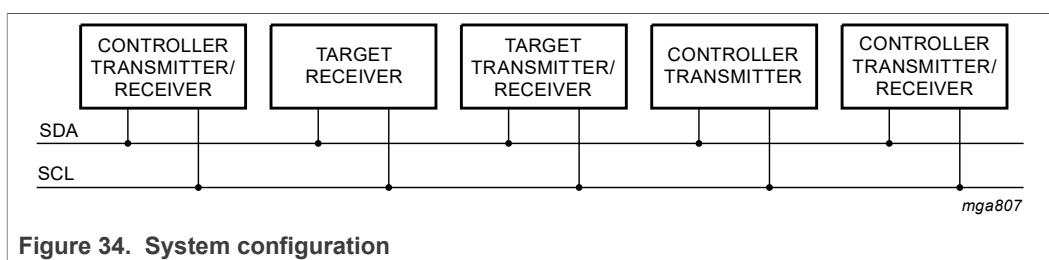


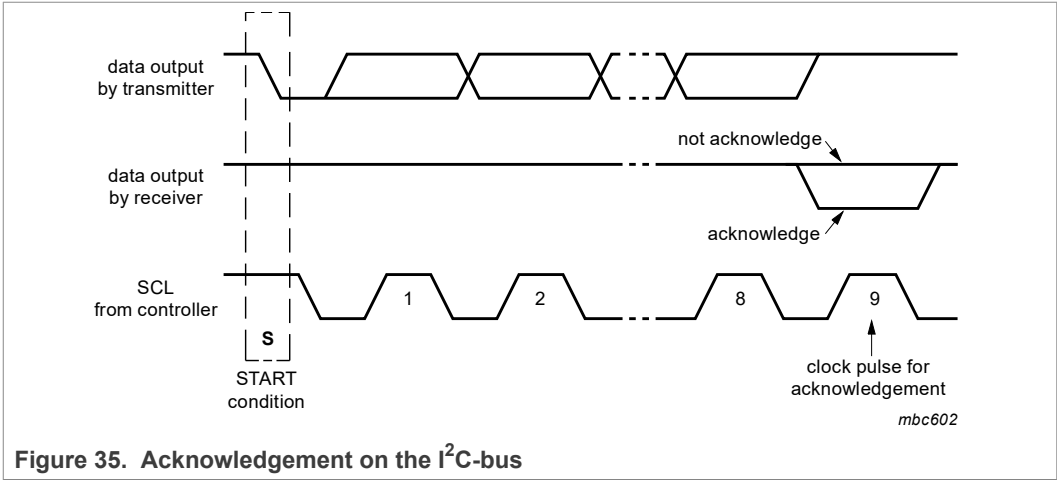
Figure 34. System configuration

### 8.2.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of 8 bits is followed by an acknowledge cycle.

- A target receiver which is addressed must generate an acknowledge after the reception of each byte.
- Also a controller receiver must generate an acknowledge after the reception of each byte that has been clocked out of the target transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be considered).
- A controller receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the target. In this event, the transmitter must leave the data line HIGH to enable the controller to generate a STOP condition.

Acknowledgement on the I<sup>2</sup>C-bus is shown in [Figure 35](#).



8.2.5 I<sup>2</sup>C-bus controller

The PCA8536 acts as an I<sup>2</sup>C-bus target receiver. It does not initiate I<sup>2</sup>C-bus transfers or transmit data to an I<sup>2</sup>C-bus controller receiver. Device selection depends on the I<sup>2</sup>C-bus target address.

8.2.6 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

8.2.7 I<sup>2</sup>C-bus target address

Device selection depends on the I<sup>2</sup>C-bus target address. Two different I<sup>2</sup>C-bus target addresses can be used to address the PCA8536 (see [Table 37](#)).

Table 37. I<sup>2</sup>C target address

Bit	target address							
	7	6	5	4	3	2	1	0
	MSB							LSB
	0	1	1	1	0	0	A0	R/W

The least significant bit of the target address byte is bit R/W. Bit 1 of the target address is defined by connecting the input A0 to either V<sub>SS</sub> (logic 0) or V<sub>DD</sub> (logic 1). Therefore, two instances of PCA8536 can be distinguished on the same I<sup>2</sup>C-bus.

8.2.8 I<sup>2</sup>C-bus protocol

The I<sup>2</sup>C-bus protocol is shown in [Figure 36](#). The sequence is initiated with a START condition (S) from the I<sup>2</sup>C-bus controller which is followed by one of the two PCA8536 target addresses available. All PCA8536 with the corresponding A0 level acknowledge in parallel to the target address, but any PCA8536 with the alternative A0 level ignore the whole I<sup>2</sup>C-bus transfer.

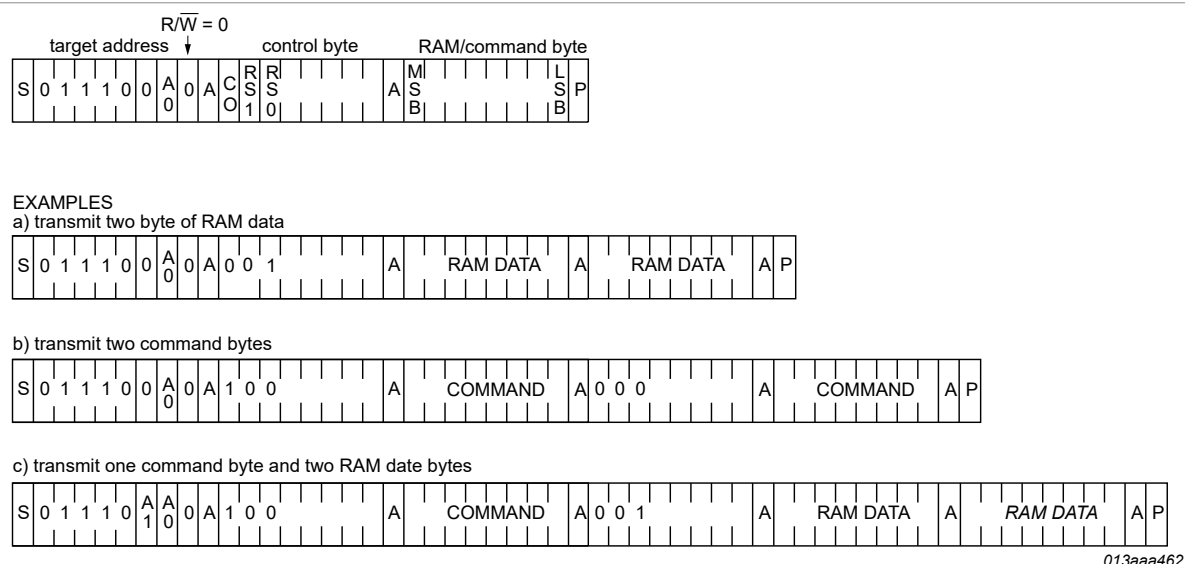
After acknowledgement, a control byte follows (see [Section 8.1](#)).



### Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

The display bytes are stored in the display RAM at the address specified by the RAM data pointer and PWM data is stored at the address pointed to by the PWM data pointer.

The acknowledgement after each byte is made only by the addressed PCA8536. After the last data byte, the I<sup>2</sup>C-bus controller issues a STOP condition (P). Alternatively a START may be issued to RESTART an I<sup>2</sup>C-bus access.



**Figure 36. I<sup>2</sup>C-bus protocol write mode**

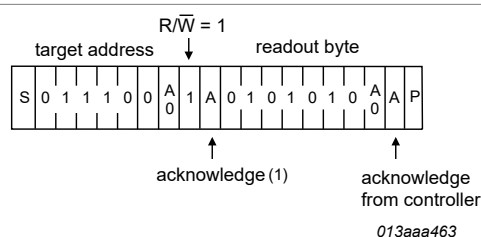
#### 8.2.8.1 Status read out

Status read out for I<sup>2</sup>C-bus operation only. This command will initiate the read out of a fixed value plus the target address bit A0 from the PCA8536. This read out function will allow the I<sup>2</sup>C controller to confirm the existence of the device on the I<sup>2</sup>C-bus.

### Table 38. Status read out value

Bit	Symbol	Value	Description
7 to 1	-	0101 010	fixed value
0	A0	0	read back value is 0101 0100
		1	read back value is 0101 0101

If a readout is made, the  $R/\overline{W}$  bit must be logic 1 and then the next data byte following is provided by the PCA8536 as shown in [Figure 37](#).



1. From PCA8536.

**Figure 37. I<sup>2</sup>C-bus protocol read mode**

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In the unlikely case that the chip has entered the internal test mode, detection of this state is possible by using the modified status read out detailed in [Table 39](#). The read out value is modified to indicate that the chip has entered an internal test mode.

Table 39. Modified status read out value

Bit	Symbol	Value	Description
7 to 1	-	1111 000	fixed value
0	A0	0	read back value is 1111 0000
		1	read back value is 1111 0001

EMC detection

The PCA8536 is ruggedized against EMC susceptibility; however it is not possible to cover all cases. To detect if a severe EMC event has occurred, it is possible to check the responsiveness of the device by reading its register.

8.3 SPI-bus interface

Data transfer to the device is made via a 3 line SPI-bus (see [Table 40](#)). There is no output data line. The SPI-bus is initialized whenever the chip enable line pin  $\overline{CE}$  is inactive.

Table 40. Serial interface

Symbol	Function	Description
$\overline{CE}$	chip enable input <sup>[1]</sup> ; active LOW	when HIGH, the interface is reset
SCL	serial clock input	input may be higher than $V_{DD}$
SDI	serial data input	input may be higher than $V_{DD}$ ; input data is sampled on the rising edge of SCL

[1] The chip enable must not be wired permanently LOW.

8.3.1 Data transmission

The chip enable signal is used to identify the transmitted data. Each data transfer is a byte with the Most Significant Bit (MSB) sent first.

The transmission is controlled by the active LOW chip enable signal  $\overline{CE}$ . The first byte transmitted is the subaddress byte.

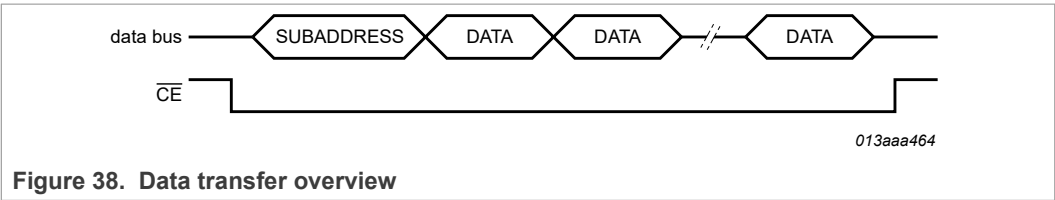


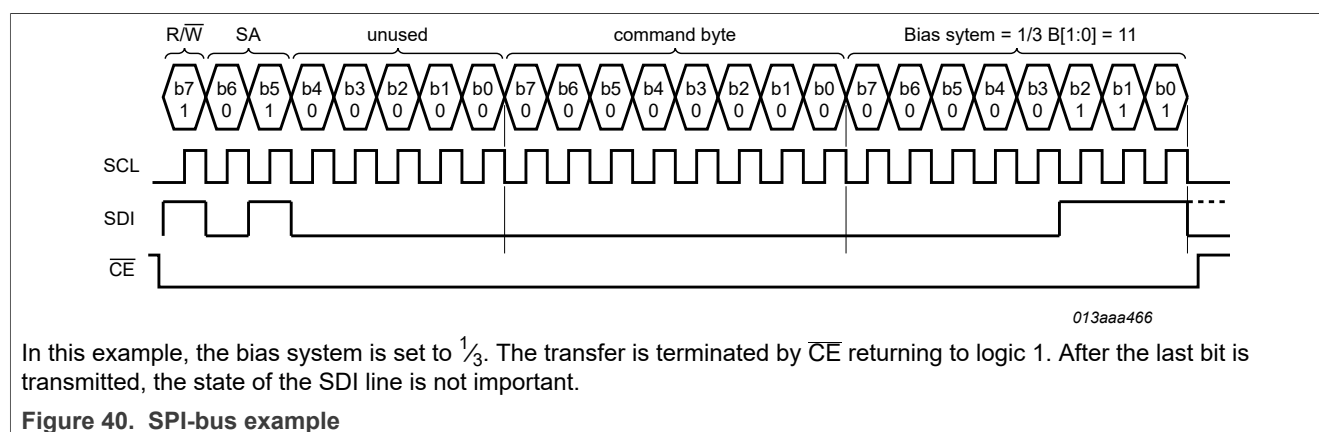
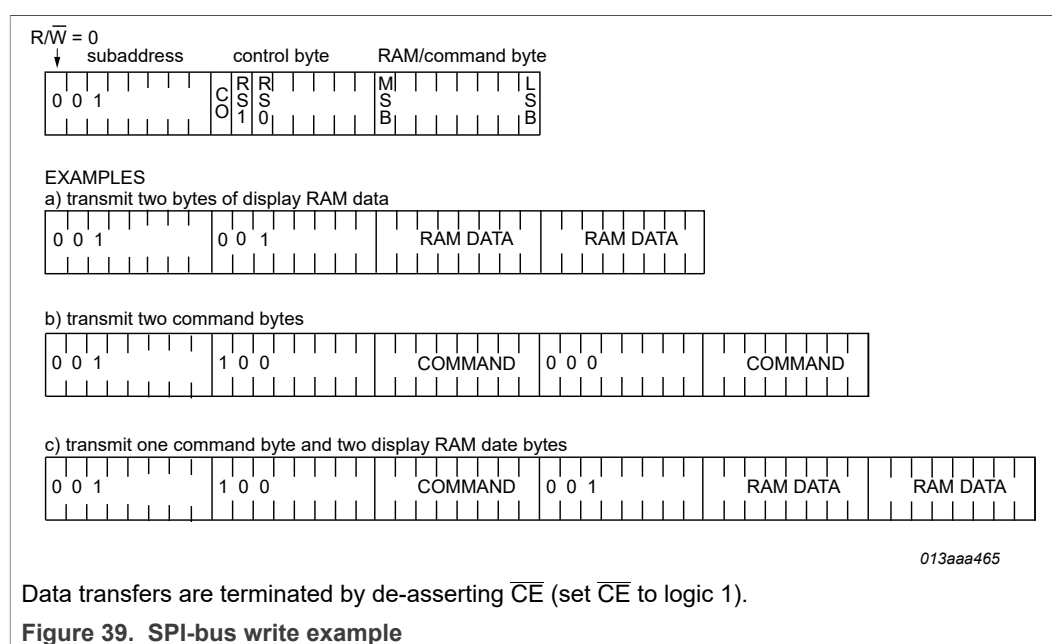
Figure 38. Data transfer overview

The subaddress byte opens the communication with a read/write bit and a subaddress. The subaddress is used to identify multiple devices on one SPI-BUS.

**Table 41. Subaddress byte definition**

Bit	Symbol	Value	Description
7	R/W		<b>data read or write selection</b>
		0	write data
		1	read data
6 to 5	SA	01	<b>subaddress</b> ; other codes will cause the device to ignore data transfer
4 to 0	-		unused

After the subaddress byte, a control byte follows (see [Section 8.1](#)).



9 Internal circuitry

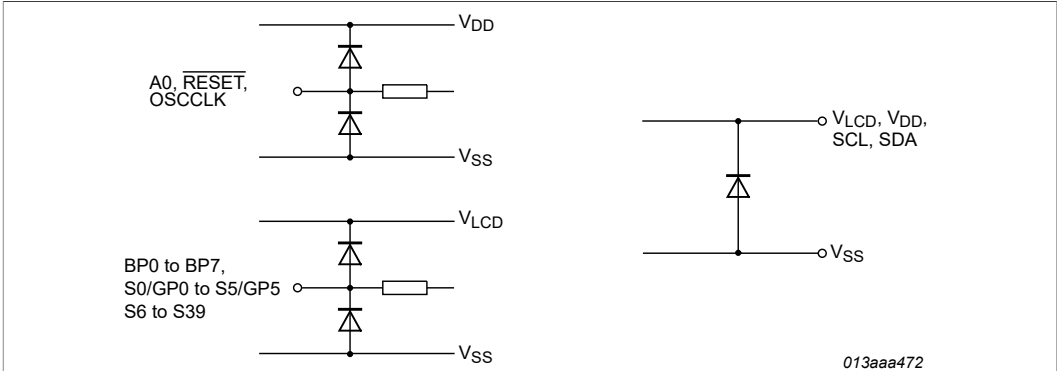


Figure 41. Device protection diagram for PCA8536AT

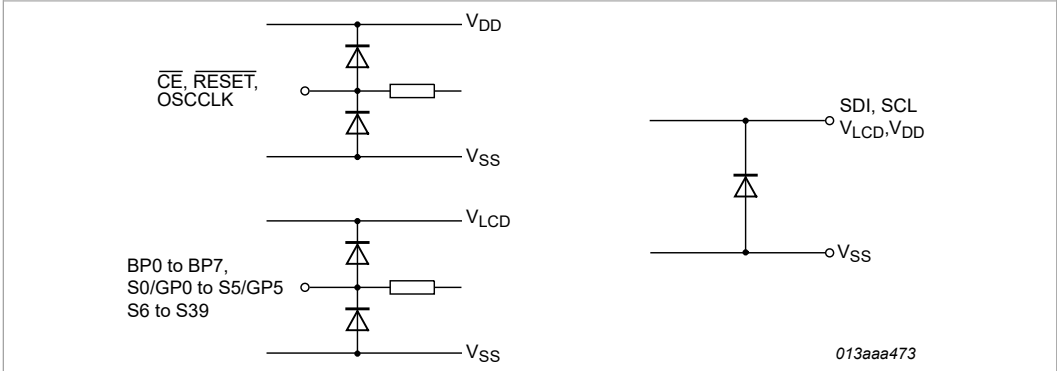



Figure 42. Device protection diagram for PCA8536BT

10 Limiting values

CAUTION



Static voltages across the liquid crystal display can build up when the LCD supply voltage ( $V_{LCD}$ ) is on while the IC supply voltage ( $V_{DD}$ ) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.

Table 42. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+6.5	V
$I_{DD}$	supply current		-50	+50	mA
$V_{LCD}$	LCD supply voltage		-0.5	+10	V
$I_{DD(LCD)}$	LCD supply current		-50	+50	mA
$V_I$	input voltage	PCA8536AT			

Table 42. Limiting values...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
		on pins SDA, OSCCLK, SCL, A0, RESET	-0.5	+6.5	V
		PCA8536BT			
		on pins $\overline{CE}$ , OSCCLK, SCL, SDI, RESET	-0.5	+6.5	V
$I_I$	input current		-10	+10	mA
$V_O$	output voltage	on pins S0/GP0 to S5/GP5, S6 to S39, BP0 to BP7	-0.5	+10	V
		on pin SDA	-0.5	+6.5	V
$I_O$	output current		-10	+10	mA
$I_{SS}$	ground supply current		-50	+50	mA
$P_{tot}$	total power dissipation		-	400	mW
$P_{out}$	power dissipation per output		-	100	mW
$V_{ESD}$	electrostatic discharge voltage	HBM	[1] -	±3 500	V
		CDM	[2] -	±1 250	V
$I_{lu}$	latch-up current		[3] -	200	mA
$T_{stg}$	storage temperature		[4] -65	+150	°C
$T_{amb}$	ambient temperature	operating device	-40	+95	°C

[1] Pass level; Human Body Model (HBM), according to [1].

[2] Pass level; Charge Device Model (CDM), according to [2].

[3] Pass level; latch-up testing according to [3] at maximum ambient temperature ( $T_{amb(max)}$ ).

[4] According to the NXP store and transport requirements (see [4]) the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %. For long-term storage products deviant conditions are described in that document.

## 11 Static characteristics

Table 43. Static characteristics

 $V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.5\text{ V to }9.0\text{ V}$ ;  $T_{amb} = -40\text{ °C to }+95\text{ °C}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Supplies</b>						
$V_{DD}$	supply voltage		1.8	-	5.5	V
$V_{LCD}$	LCD supply voltage	$V_{LCD} \geq V_{DD}$	2.5	-	9.0	V
$I_{DD(pd)}$	power-down mode supply current		[1] -	0.5	2	µA
$I_{DD}$	supply current	see Figure 43				
		external 9.6 kHz clock	[2] -	10	25	µA
		external 230 kHz clock with PWM	[3] -	20	40	µA
		internal oscillator	[2] -	30	60	µA

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 43. Static characteristics...continued

$V_{DD} = 1.8 \text{ V to } 5.5 \text{ V}$ ;  $V_{SS} = 0 \text{ V}$ ;  $V_{LCD} = 2.5 \text{ V to } 9.0 \text{ V}$ ;  $T_{amb} = -40 \text{ }^{\circ}\text{C to } +95 \text{ }^{\circ}\text{C}$ ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
		internal oscillator with PWM	[3]	-	60	130	μA
I <sub>DD(LCD)</sub>	LCD supply current	power-down, see <a href="#">Figure 44</a>	[1][4]	-	7	15	μA
		display active, see <a href="#">Figure 45</a>	[5]	-	55	140	μA
Logic							
V <sub>I</sub>	input voltage			V <sub>SS</sub> - 0.5	-	V <sub>DD</sub> + 0.5	V
V <sub>IL</sub>	LOW-level input voltage	on pins OSCCLK, A0 and $\overline{\text{RESET}}$		-	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage	on pins OSCCLK, A0 and $\overline{\text{RESET}}$		0.7V <sub>DD</sub>	-	-	V
V <sub>O</sub>	output voltage			-0.5	-	V <sub>DD</sub> + 0.5	V
V <sub>OH</sub>	HIGH-level output voltage	driving load of 50 μA on pins OSCCLK and GP0 to GP5		0.8V <sub>DD</sub>	-	-	V
V <sub>OL</sub>	LOW-level output voltage	driving load of 50 μA on pins OSCCLK and GP0 to GP5		-	-	0.2V <sub>DD</sub>	V
I <sub>OH</sub>	HIGH-level output current	output source current; V <sub>OH</sub> = V <sub>DD</sub> - 0.4 V					
		on pin OSCCLK					
		V <sub>DD</sub> = 1.8 V		0.7	1.6	-	mA
		V <sub>DD</sub> ≥ 3.3 V		1.5	4.0	-	mA
		on pins GP0 to GP5					
		V <sub>DD</sub> = 1.8 V; V <sub>LCD</sub> = 2.5 V		0.7	1.1	-	mA
I <sub>OL</sub>	LOW-level output current	output sink current; V <sub>OL</sub> = 0.4 V					
		on pin OSCCLK					
		V <sub>DD</sub> = 1.8 V		3	4	-	mA
		V <sub>DD</sub> ≥ 3.3 V		5	10	-	mA
		on pins GP0 to GP5					
		V <sub>DD</sub> = 1.8 V; V <sub>LCD</sub> = 2.5 V		0.7	1.1	-	mA

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 43. Static characteristics...continued

$V_{DD} = 1.8 \text{ V to } 5.5 \text{ V}$ ;  $V_{SS} = 0 \text{ V}$ ;  $V_{LCD} = 2.5 \text{ V to } 9.0 \text{ V}$ ;  $T_{amb} = -40 \text{ }^{\circ}\text{C to } +95 \text{ }^{\circ}\text{C}$ ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
		$V_{DD} = 3.3\text{ V};$ $V_{LCD} \geq 5.5\text{ V}$		1.5	2.4	-	mA
I <sub>L</sub>	leakage current	V <sub>i</sub> = V <sub>DD</sub> or V <sub>SS</sub> ; on pin OSCCLK and GP0 to GP5		-1	-	+1	μA
<b>I<sup>2</sup>C-bus</b> <sup>[6]</sup>							
On pins SCL and SDA							
V <sub>I</sub>	input voltage			V <sub>SS</sub> - 0.5	-	5.5	V
V <sub>IL</sub>	LOW-level input voltage			-	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage			0.7V <sub>DD</sub>	-	-	V
V <sub>O</sub>	output voltage			-0.5	-	+5.5	V
I <sub>L</sub>	leakage current	V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub>		-1	-	+1	μA
On pin SDA							
I <sub>OL</sub>	LOW-level output current	output sink current					
		$V_{DD} = 1.8\text{ V}$		3	5.5	-	mA
		$V_{DD} = 3.3\text{ V}$		5	9	-	mA
<b>SPI-bus</b>							
V <sub>I</sub>	input voltage	on pin SCL		V <sub>SS</sub> - 0.5	-	5.5	V
		on pins $\overline{\text{CE}}$ and SDI		V <sub>SS</sub> - 0.5	-	V <sub>DD</sub> + 0.5	V
On pins SCL, $\overline{\text{CE}}$ and SDI							
V <sub>IL</sub>	LOW-level input voltage			-	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage			0.7V <sub>DD</sub>	-	-	V
I <sub>L</sub>	leakage current	V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub>		-1	-	+1	μA
<b>LCD outputs</b>							
ΔV <sub>O</sub>	output voltage variation	on pins BP0 to BP7	<sup>[7]</sup>	-	2.5	+10	mV
		on pins S0 to S43	<sup>[8]</sup>	-	2.5	+10	mV
R <sub>O</sub>	output resistance	V <sub>LCD</sub> = 7 V; on pins BP0 to BP7	<sup>[9]</sup>	-	0.9	5.0	kΩ
		V <sub>LCD</sub> = 7 V; on pins S0 to S43	<sup>[9]</sup>	-	1.5	6.0	kΩ

[1] Power-down mode is enabled; I<sup>2</sup>C-bus or SPI-bus inactive.

[2] 1:8 multiplex drive mode; 1/4 bias; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; inputs at  $V_{SS}$  or  $V_{DD}$ ; default display prescale factor; I<sup>2</sup>C-bus or SPI-bus inactive.

[3] 1:8 multiplex drive mode; 1/4 bias; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; inputs at  $V_{SS}$  or  $V_{DD}$ ; default display prescale factor; I<sup>2</sup>C-bus or SPI-bus inactive; six PWM channels active at 50 % duty.

[4] Strongly linked to  $V_{LCD}$  voltage. See Figure 44.

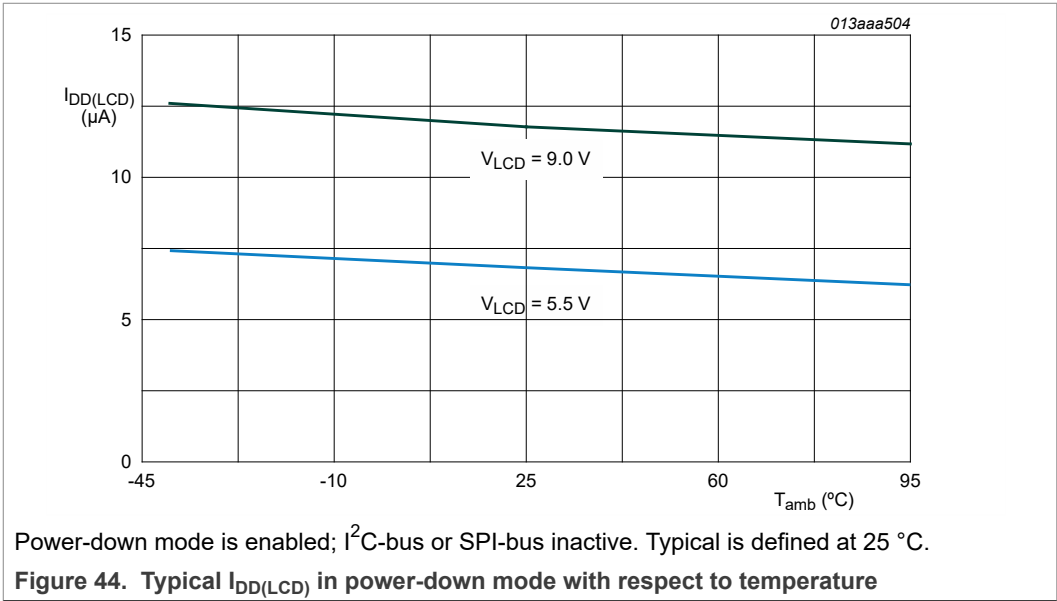
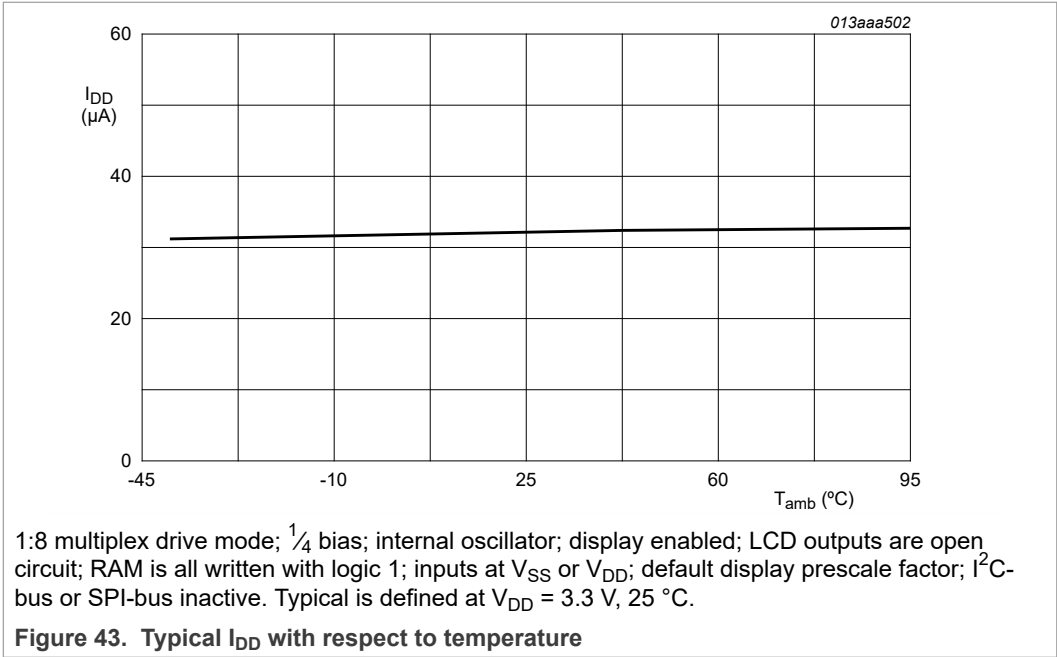
[5] 1:8 multiplex drive mode; 1/4 bias; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; default display prescale factor.

[6] The I<sup>2</sup>C-bus interface of PCA8536 is 5 V tolerant.

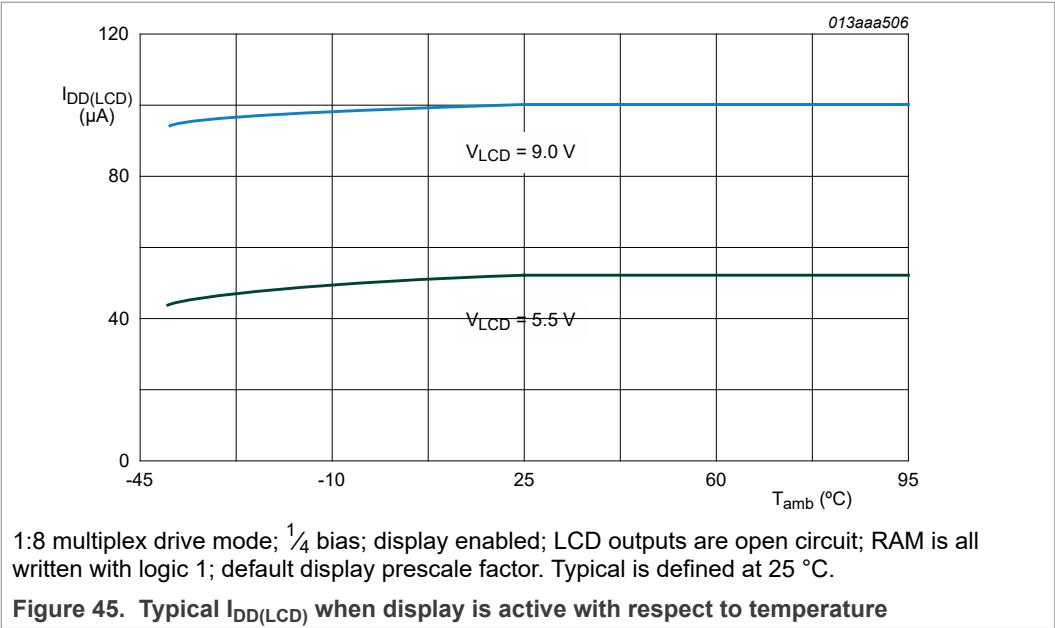
[7] Variation between any two backplanes on a given voltage level; static measured.

[8] Variation between any two segments on a given voltage level; static measured.

[9] Outputs measured one at a time.







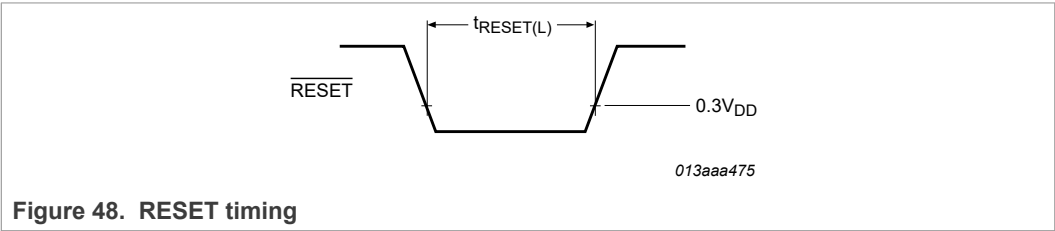
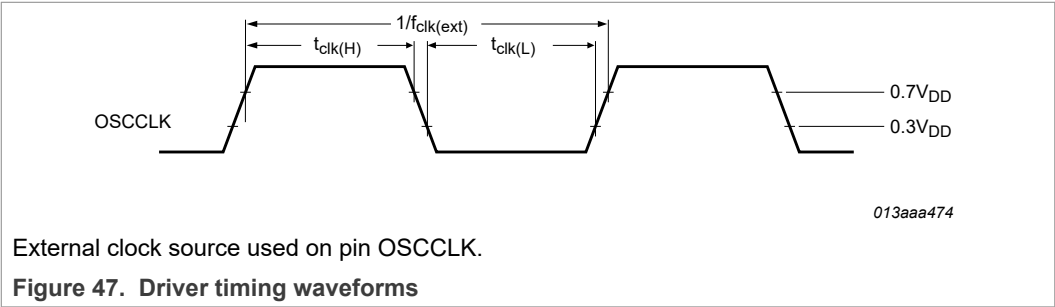
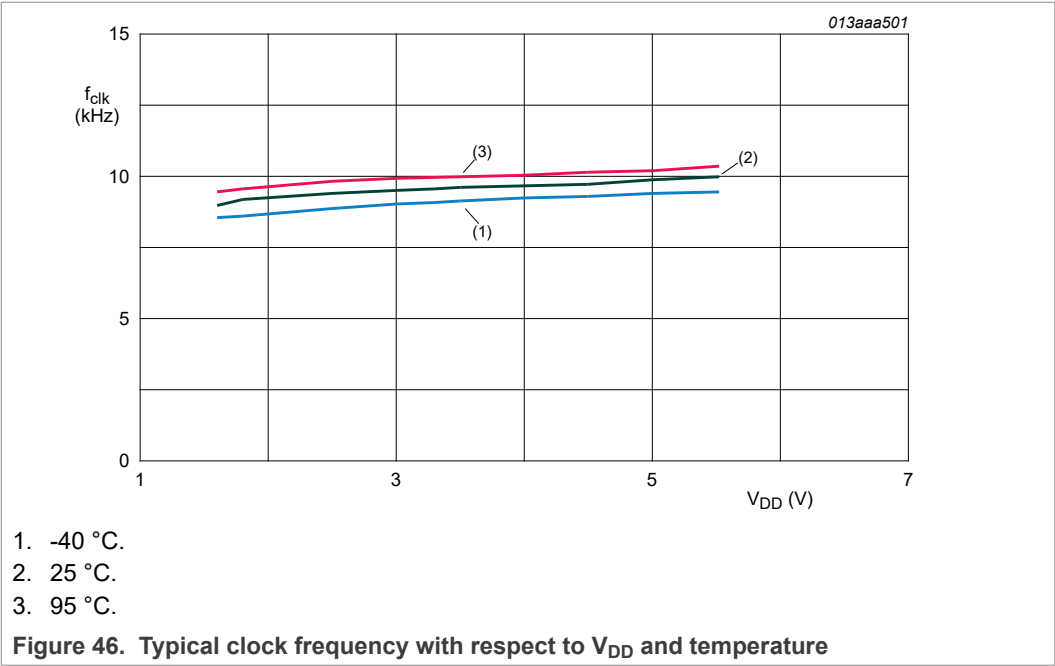
12 Dynamic characteristics

Table 44. Dynamic characteristics

$V_{DD} = 1.8 V$  to  $5.5 V$ ;  $V_{SS} = 0 V$ ;  $V_{LCD} = 2.5 V$  to  $9.0 V$ ;  $T_{amb} = -40\text{ }^{\circ}C$  to  $+95\text{ }^{\circ}C$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$f_{clk}$	clock frequency	output on pin OSCCLK; $V_{DD} = 3.3 V$	<sup>[1]</sup> 7 800	9 600	11 040	Hz
$f_{clk(ext)}$	external clock frequency	EFR = 0	-	-	250 000	Hz
$t_{(RESET\_N)}$	RESET_N pulse width	LOW time	400	-	-	ns
External clock source used on pin OSCCLK						
$t_{clk(H)}$	clock HIGH time		33	-	-	$\mu s$
$t_{clk(L)}$	clock LOW time		33	-	-	$\mu s$

[1] Frequency present on OSCCLK with default display frequency division factor.



**Table 45. Timing characteristics: I<sup>2</sup>C-bus**  
 $V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.5\text{ V to }9.0\text{ V}$ ;  $T_{amb} = -40\text{ °C to }+95\text{ °C}$ ; unless otherwise specified. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ . Timing waveforms see [Figure 49](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Pin SCL</b>						
$f_{SCL}$	SCL clock frequency		[1] -	-	400	kHz

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

**Table 45. Timing characteristics: I<sup>2</sup>C-bus...continued**

$V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.5\text{ V to }9.0\text{ V}$ ;  $T_{amb} = -40\text{ °C to }+95\text{ °C}$ ; unless otherwise specified. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ . Timing waveforms see [Figure 49](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$t_{LOW}$	LOW period of the SCL clock		1.3	-	-	$\mu\text{s}$
$t_{HIGH}$	HIGH period of the SCL clock		0.6	-	-	$\mu\text{s}$
<b>Pin SDA</b>						
$t_{SU,DAT}$	data set-up time		100	-	-	ns
$t_{HD,DAT}$	data hold time		0	-	-	ns
<b>Pins SCL and SDA</b>						
$t_{BUF}$	bus free time between a STOP and START condition		1.3	-	-	$\mu\text{s}$
$t_{SU,STO}$	set-up time for STOP condition		0.6	-	-	$\mu\text{s}$
$t_{HD,STA}$	hold time (repeated) START condition		0.6	-	-	$\mu\text{s}$
$t_{SU,STA}$	set-up time for a repeated START condition		0.6	-	-	$\mu\text{s}$
$t_r$	rise time of both SDA and SCL signals	$f_{SCL} = 400\text{ kHz}$	-	-	0.3	$\mu\text{s}$
		$f_{SCL} = 100\text{ kHz}$	-	-	1.0	$\mu\text{s}$
$t_f$	fall time of both SDA and SCL signals		-	-	0.3	$\mu\text{s}$
$t_{VD,ACK}$	data valid acknowledge time		[2] 0.6	-	-	$\mu\text{s}$
$t_{VD,DAT}$	data valid time		[3] 0.6	-	-	$\mu\text{s}$
$C_b$	capacitive load for each bus line		-	-	400	pF
$t_{SP}$	pulse width of spikes that must be suppressed by the input filter		[4] -	-	50	ns

[1] The minimum SCL clock frequency is limited by the bus time-out feature, which resets the serial bus interface if either the SDA or SCL is held LOW for a minimum of 25 ms. The bus time-out feature must be disabled for DC operation.

[2]  $t_{VD,ACK}$  = time for acknowledgement signal from SCL LOW to SDA output LOW.

[3]  $t_{VD,DAT}$  = minimum time for valid SDA output following SCL LOW.

[4] Input filters on the SDA and SCL inputs suppress noise spikes of less than 50 ns.

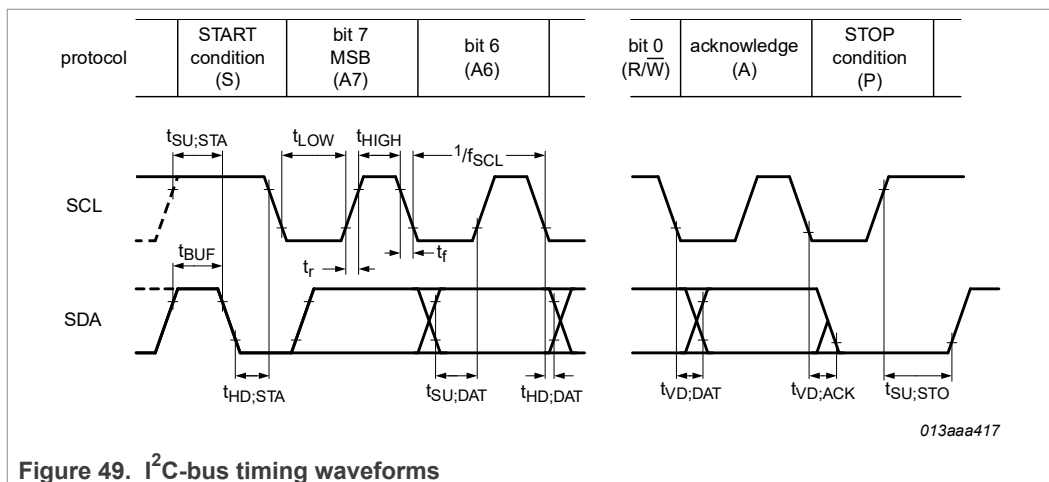
Figure 49. I<sup>2</sup>C-bus timing waveforms

Table 46. Timing characteristics: SPI-bus

$V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = -40\text{ °C to }+95\text{ °C}$ . All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ . Timing waveforms see Figure 50.

Symbol	Parameter	Conditions	$V_{DD} < 2.7\text{ V}$		$V_{DD} \geq 2.7\text{ V}$		Unit
			Min	Max	Min	Max	
$f_{clk}(SCL)$	SCL clock frequency		-	2	-	5	MHz
$t_{SCL}$	SCL time		500	-	200	-	ns
$t_{clk(H)}$	clock HIGH time		200	-	80	-	ns
$t_{clk(L)}$	clock LOW time		200	-	80	-	ns
$t_r$	rise time	for SCL signal	-	100	-	100	ns
$t_f$	fall time	for SCL signal	-	100	-	100	ns
$t_{su}(CE\_N)$	CE_N set-up time		150	-	80	-	ns
$t_h(CE\_N)$	CE_N hold time		0	-	0	-	ns
$t_{rec}(CE\_N)$	CE_N recovery time		100	-	100	-	ns
$t_{su}$	set-up time	set-up time for SDI data	10	-	5	-	ns
$t_h$	hold time	hold time for SDI data	25	-	10	-	ns

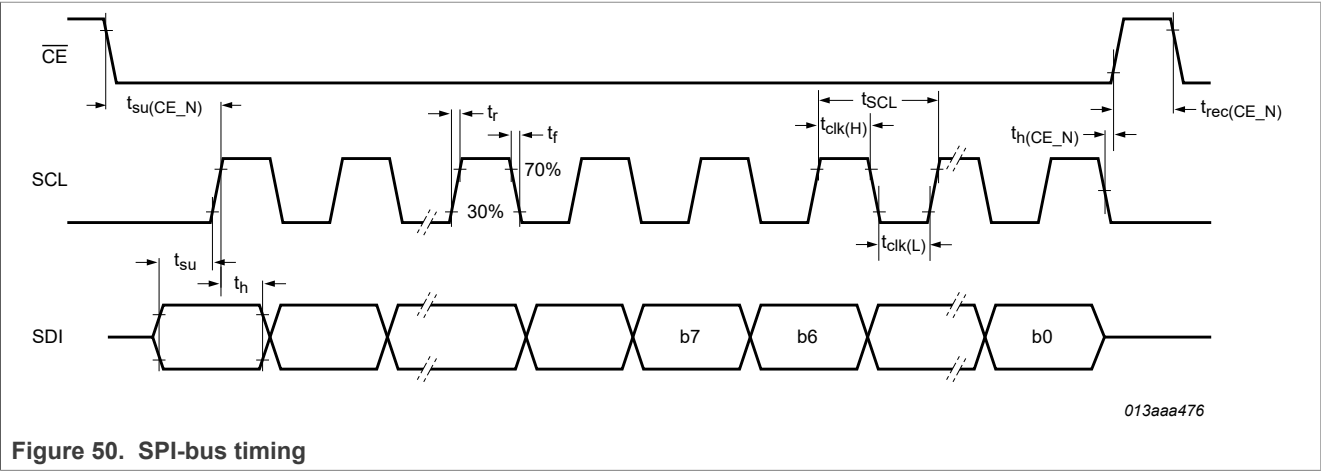


Figure 50. SPI-bus timing

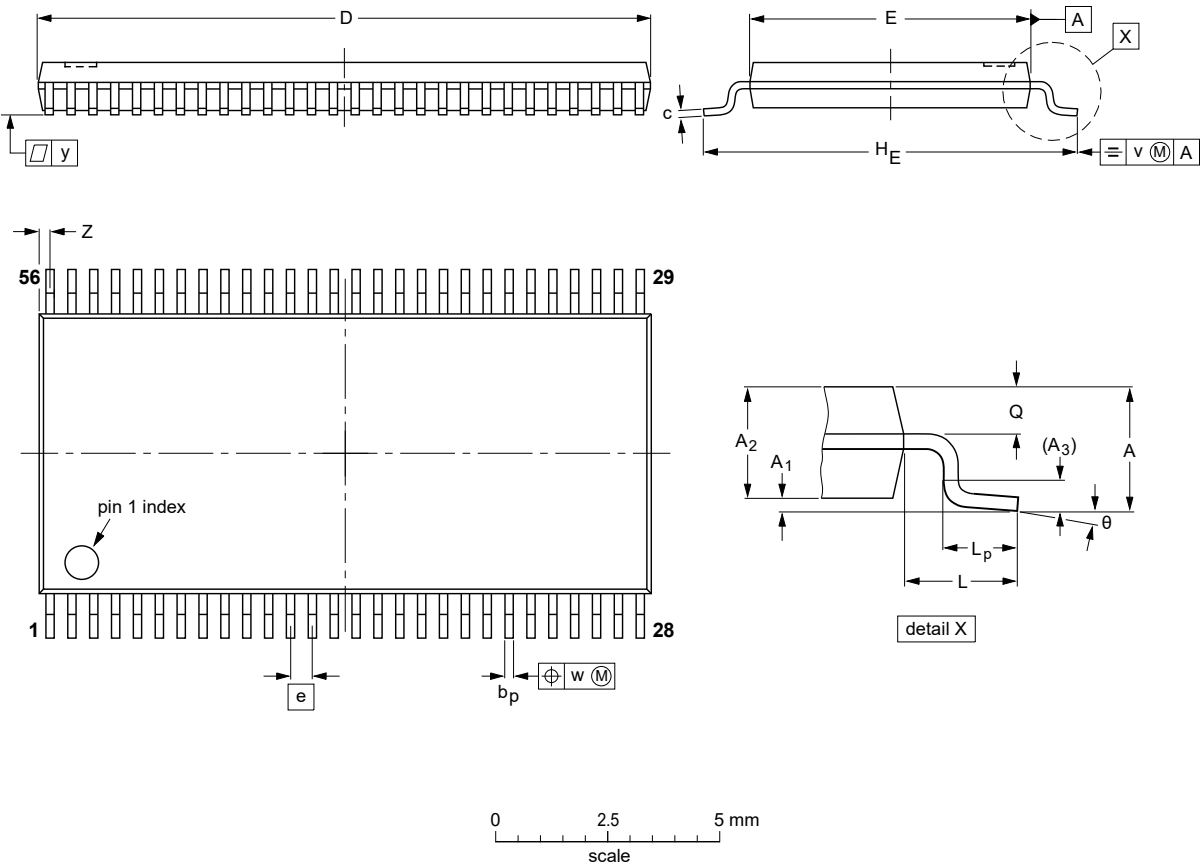
## 13 Test information

### 13.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q100 - *Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

14 Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm SOT364-1



DIMENSIONS (mm are the original dimensions).

UNIT	A <sub>max.</sub>	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT364-1		MO-153				99-12-27 03-02-19

Figure 51. Package outline SOT364-1 (TSSOP56)

## 15 Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

## 16 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 16.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 16.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 16.3 Wave soldering

Key characteristics in wave soldering are:

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

## 16.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see [Figure 52](#)) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with [Table 47](#) and [Table 48](#)

Table 47. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)	
	Volume (mm <sup>3</sup> )	
	< 350	≥ 350
< 2.5	235	220
≥ 2.5	220	220

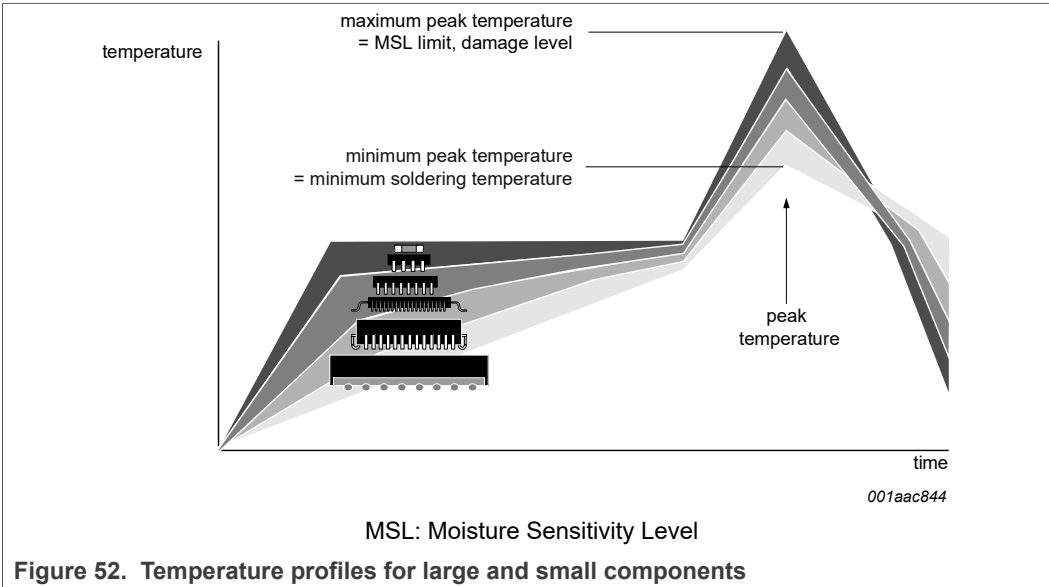
Table 48. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)		
	Volume (mm <sup>3</sup> )		
	< 350	350 to 2000	> 2000
< 1.6	260	260	260
1.6 to 2.5	260	250	245
> 2.5	250	245	245

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see [Figure 52](#).





For further information on temperature profiles, refer to Application Note AN10365 “Surface mount reflow soldering description”.

17 Footprint information for reflow soldering

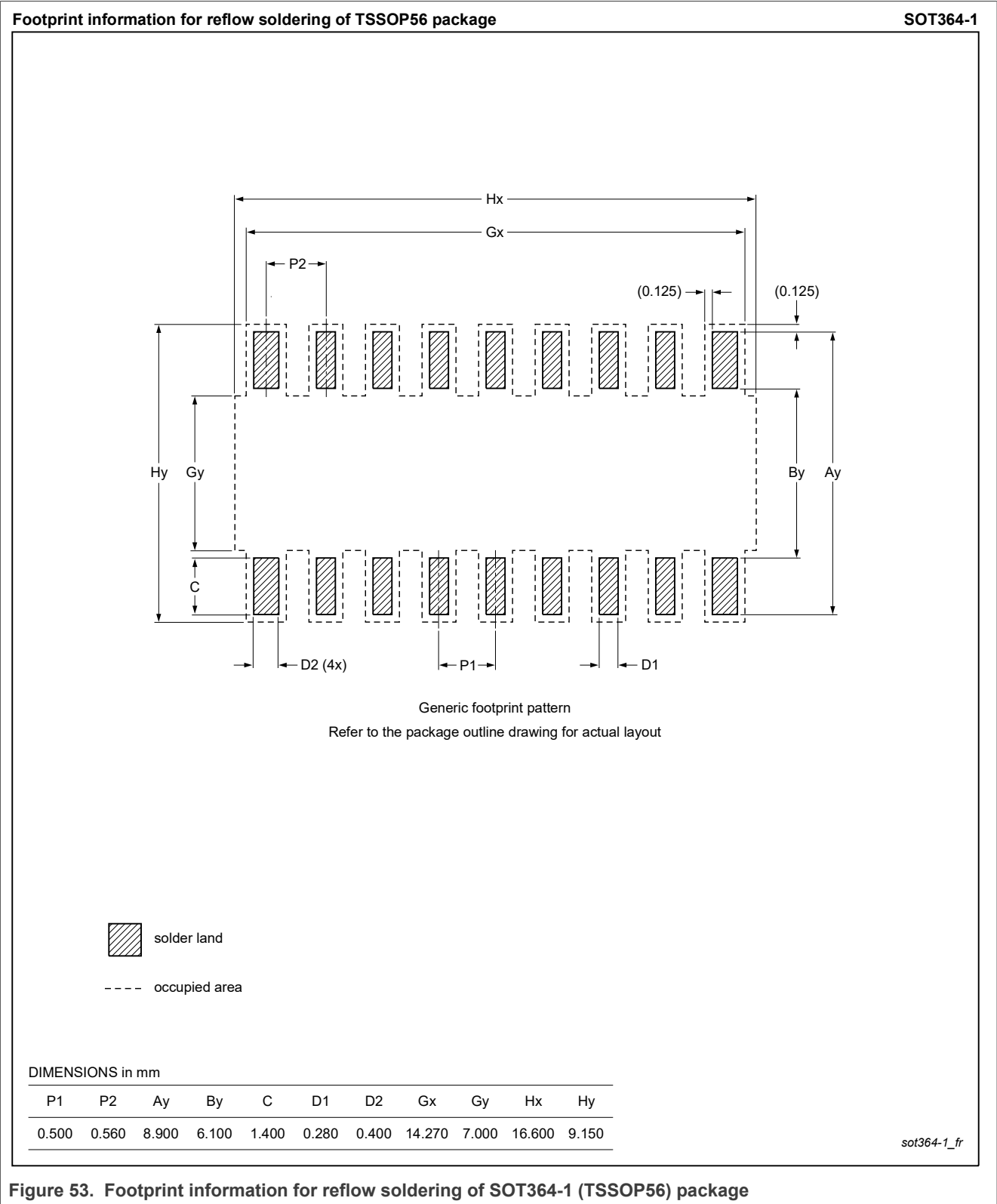


Figure 53. Footprint information for reflow soldering of SOT364-1 (TSSOP56) package

## 18 Appendix: possible PWM and LCD frame frequency combinations to avoid flicker

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## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 49. LCD and PWM frame frequency combinations to avoid flicker<sup>[1]</sup>

Experiments have shown that likely no flicker occurs when PWM frame frequency and LCD frame frequency are between 40 Hz and 50 Hz apart and no flicker occurs if they are more than 50 Hz apart.

frame frequencies	PWM (f <sub>PWM</sub> )															
LCD (f <sub>fr(LCD)</sub> )	59.9	69.1	81.7	89.8	99.8	112.3	119.8	128.3	138.2	149.7	163.4	179.7	199.7	224.6	256.7	299.5
59.9	0.0	9.2	21.8	29.9	20.0	7.5	0.0	8.6	18.4	29.9	16.3	0.0	20.0	15.0	17.1	0.0
70.5	10.6	1.4	11.2	19.4	29.4	28.6	21.1	12.6	2.7	8.8	22.4	31.7	11.7	13.2	25.2	17.6
79.9	20.0	10.8	1.8	10.0	20.0	32.4	39.9	31.4	21.5	10.0	3.6	20.0	39.9	15.0	17.1	20.0
90.4	29.4	21.3	8.7	0.6	9.4	21.9	29.4	37.9	42.6	31.1	17.5	1.1	18.8	43.8	14.5	28.3
99.8	20.0	30.7	18.2	10.0	0.0	12.5	20.0	28.5	38.4	49.9	36.3	20.0	0.0	25.0	42.8	0.0
108.9	10.9	29.3	27.2	19.1	9.1	3.4	10.9	19.4	29.3	40.8	54.5	38.1	18.2	6.8	38.9	27.2
119.8	0.0	18.4	38.1	29.9	20.0	7.5	0.0	8.6	18.4	29.9	43.6	59.9	39.9	15.0	17.1	59.9
129.5	9.7	8.7	33.8	39.7	29.7	17.2	9.7	1.2	8.7	20.2	33.8	50.2	59.4	34.4	2.3	40.5
140.9	21.1	2.7	22.4	38.8	41.1	28.6	21.1	12.6	2.7	8.8	22.4	38.8	58.7	57.3	25.2	17.6
149.7	29.9	11.5	13.6	29.9	49.9	37.4	29.9	21.4	11.5	0.0	13.6	29.9	49.9	74.9	42.8	0.0
159.7	20.0	21.5	3.6	20.0	39.9	47.4	39.9	31.4	21.5	10.0	3.6	20.0	39.9	64.9	62.7	20.0
171.1	8.6	32.9	7.8	8.6	28.5	53.5	51.3	42.8	32.9	21.4	7.8	8.6	28.5	53.5	85.6	42.8
177.5	2.2	29.9	14.1	2.2	22.2	47.1	57.7	49.1	39.2	27.7	14.1	2.2	22.2	47.1	79.2	55.5
184.3	4.6	23.0	20.9	4.6	15.4	40.3	55.3	55.9	46.1	34.6	20.9	4.6	15.4	40.3	72.4	69.1
191.7	12.0	15.7	28.3	12.0	8.0	32.9	47.9	63.3	53.4	41.9	28.3	12.0	8.0	32.9	65.0	83.9
199.7	20.0	7.7	36.3	20.0	0.0	25.0	39.9	57.0	61.4	49.9	36.3	20.0	0.0	25.0	57.0	99.8
208.3	28.6	1.0	36.7	28.6	8.7	16.3	31.3	48.4	68.1	58.6	45.0	28.6	8.7	16.3	48.4	91.1
217.8	21.8	10.5	27.2	38.1	18.2	6.8	21.8	38.9	58.6	68.1	54.5	38.1	18.2	6.8	38.9	81.7
228.2	11.4	20.8	16.9	41.4	28.5	3.6	11.4	28.5	48.3	71.3	64.8	48.5	28.5	3.6	28.5	71.3
239.6	0.0	32.3	5.4	29.9	39.9	15.0	0.0	17.1	36.9	59.9	76.2	59.9	39.9	15.0	17.1	59.9
252.2	12.6	24.2	7.2	17.3	47.3	27.6	12.6	4.5	24.2	47.3	74.5	72.5	52.5	27.6	4.5	47.3
266.2	26.6	10.2	21.2	3.3	33.3	41.6	26.6	9.5	10.2	33.3	60.5	86.5	66.6	41.6	9.5	33.3
281.9	17.6	5.4	36.8	12.3	17.6	55.1	42.3	25.2	5.4	17.6	44.8	77.5	82.2	57.3	25.2	17.6

## Automotive LCD driver for low multiplex rates including a 6 channel PWM generator

Table 49. LCD and PWM frame frequency combinations to avoid flicker <sup>[1]</sup>...continued

Experiments have shown that likely no flicker occurs when PWM frame frequency and LCD frame frequency are between 40 Hz and 50 Hz apart and no flicker occurs if they are more than 50 Hz apart.

frame frequencies	PWM (f <sub>PWM</sub> )															
LCD (f <sub>fr(LCD)</sub> )	59.9	69.1	81.7	89.8	99.8	112.3	119.8	128.3	138.2	149.7	163.4	179.7	199.7	224.6	256.7	299.5
299.5	0.0	23.0	27.2	29.9	0.0	37.4	59.9	42.8	23.0	0.0	27.2	59.9	99.8	74.9	42.8	0.0

[1] The table shows the smallest distance ( $\Delta f$ ) from one frequency to the next or multiples of the next.  $\Delta f = \text{MIN}(f_1 - n \times f_2)$ ; the values for n are 1 to 6; f1 and f2 can be either f<sub>PWM</sub> or f<sub>fr(LCD)</sub>; both relationships have to be considered. A PWM frame frequency (f<sub>PWM</sub>) of less than 60 Hz may show flicker purely from the LCD.

## 19 Abbreviations

Table 50. Abbreviations

Acronym	Description
AEC	Automotive Electronics Council
CDM	Charged-Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DC	Direct Current
EMC	ElectroMagnetic Compatibility
EPROM	Erasable Programmable Read-Only Memory
ESD	ElectroStatic Discharge
HBM	Human Body Model
I <sup>2</sup> C	Inter-Integrated Circuit bus
IC	Integrated Circuit
LCD	Liquid Crystal Display
LED	Light-Emitting Diode
LSB	Least Significant Bit
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
MUX	Multiplexer
OTP	One Time Programmable
PCB	Printed-Circuit Board
POR	Power-On Reset
PWM	Pulse-Width Modulation
RC	Resistance-Capacitance
RAM	Random Access Memory
RGB	Red Green Blue
RMS	Root Mean Square
SCL	Serial CLock line
SDA	Serial DATa line
SPI	Serial Peripheral Interface

## 20 References

- [1] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [2] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [3] JESD78 IC Latch-Up Test
- [4] NX3-00092 NXP store and transport requirements

## 21 Revision history

Table 51. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA8536 v.3	20211006	Product data sheet	PCN202102010F01	PCA8536 v.2
Modifications:	<ul style="list-style-type: none"><li>Updated <a href="#">Ordering information</a>, including addition of <a href="#">Ordering options</a>. See Change notice column in this table.</li><li>Removed Marking section (formerly Section 5).</li><li>The terms "master" and "slave" changed to "controller" and "target" to comply with NXP inclusive language policy.</li></ul>			
PCA8536 v.2	20120221	Product data sheet	-	PCA8536 v.1
Modifications:	<ul style="list-style-type: none"><li>Fixed typos</li></ul>			
PCA8536 v.1	20111006	Product data sheet	-	-

## 22 Legal information

### 22.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

### 22.2 Definitions

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